

BQ25960 I²C 制御、バイパス・モードおよびデュアル入力選択機能搭載、 ーセル 8A スイッチト・キャパシタ・パラレル・バッテリ・チャージャ

1 特長

- 8A の高速充電をサポートするピーク効率 98.1% のス イッチト・キャパシタ・パラレル充電器
- 最高効率を実現するよう最適化されたデュアルフェー ズ・スイッチト・キャパシタ・アーキテクチャ (特許出願 中)
 - 入力電圧はバッテリ電圧の2倍
 - 出力電流は入力電流の2倍
 - Aカケーブルの電源損失を低減
- 5A バイパス・モード高速充電機能を搭載
 - 5A 入力と 5A 出力充電電流をサポートする R_{dson} 21mΩ の充電パス抵抗
- 高速充電中の電源選択とUSB On-The-Go (OTG) / 逆方向 TX モードに対応可能なデュアル入力電源マ ルチプレクサ・コントローラ
- 幅広い入力電圧をサポート
 - 最大 12.75V の動作時入力電圧
 - 最大 40V の入力電圧に加え、外付け ACFET お よび外付け ACFET なしの 20V をオプション追加
- 最大 13A の充電電流で、同期動作する 2 台の BQ25960 に並列充電が可能
- 安全な動作の実現に役立つ、プログラマブルな各種保 護機能を統合
 - 入力過電圧保護 (BUSOVP) およびバッテリ過電 圧保護 (BATOVP)
 - 入力過電流保護 (BUSOCP) およびバッテリ過電 流保護 (BATOCP)
 - 出力過電圧保護 (VOUTOVP)
 - 入力低電流保護 (BUSUCP) と入力逆電流保護 (BUSRCP) によるアダプタの抜け検出およびブー ストバック防止機能
 - バッテリおよびコネクタ温度のモニタリング機能 (TSBAT FLT および TSBUS FLT)
 - 接合部過熱保護 (TDIE FLT)
- プログラム可能な設定によるシステム最適化
 - 割り込みおよび割り込みマスク
 - ADC の読み取りと構成
 - ホスト制御用アラーム機能
- 電圧、電流、温度モニタリングのための 16 ビット ADC を内蔵

2 アプリケーション

- スマートフォン
- タブレット

3 概要

BQ25960 は、1 セルのリチウムイオン・バッテリ向けのスイ ッチト・キャパシタ・アーキテクチャを使用した、効率 98.1% の 8A バッテリ充電ソリューションです。スイッチト・ キャパシタ・アーキテクチャにより、ケーブル電流は充電電 流の半分になり、その結果、ケーブルの電源損失を低減 して、温度上昇を抑えることができます。デュアルフェー ズ・アーキテクチャにより、充電効率が上がり、入力と出力 に必要な容量は減少します。BQ2561x または BQ2589x などのメイン充電器と組み合わせて使用すると、システム は定電流 (CC) および定電圧 (CV) モードにおける電力 損失を低減することで、トリクル充電から終端までのフル充 電サイクルを有効にすることが可能です。

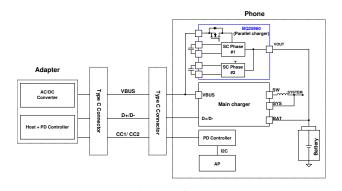
BQ25960 は、内蔵 MOSFET を経由する 5A バイパス・ モード充電 (旧名称はバッテリ・スイッチ充電) にも対応し ています。バイパス・モード充電経路の R_{dson} は、大電流 動作時で 21mΩ です。 内蔵のバイパス・モードは 5V 高 速充電アダプタとの下位互換性があり、1 セルのバッテリ を充電することが可能です。

このデバイスは、内蔵のマルチプレクサ制御と外付け N-FET 用ドライバを経由するデュアル入力構成に対応して います。また、外付け N-FET がない場合や、単一 N-FET におけるシングル入力も可能です。

製品情報

| 部品番号(1) | パッケージ | 本体サイズ (公称) |
|---------|------------|-----------------|
| BQ25960 | DSBGA (36) | 2.55mm x 2.55mm |

利用可能なすべてのパッケージについては、このデータシートの 末尾にある注文情報を参照してください。



簡略回路図



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4 Revision History

| DATE | REVISION | NOTES |
|---------------|----------|------------------|
| February 2021 | * | Initial release. |



5 概要 (続き)

このデバイスには、安全な充電をサポートするために必要なすべての保護機能が搭載されています。例として、入力過電 圧および過電流保護、出力過電圧および過電流保護、入力低電流および逆電流保護、バッテリとケーブルの温度センシング、スイッチト・キャパシタとバイパス・モードの両方に対応した接合部過熱保護機能が挙げられます。

このデバイスには 16 ビットのアナログ / デジタル・コンバータ (ADC) が内蔵されており、VAC 電圧、バス電圧、バス電流、出力電圧、バッテリ電圧、バッテリ電流、入力コネクタ温度、バッテリ温度、接合部温度、およびアダプタやワイヤレス入力やパワーバンクからのバッテリ充電を管理するために必要なその他の算出測定値を提供します。



6 Device Comparison Table

表 6-1. Device Comparison

| FUNCTION | BQ25960 | BQ25970 | BQ25968 | BQ25980 |
|----------------------------------|------------------------------|---------------------|---------------------|------------------------------|
| Package | YBG-36 | YFF-56 | YFF-56 | YFF-80 |
| Die size | 6.5 mm ² | 9.5 mm ² | 9.5 mm ² | 13.2 mm ² |
| Battery | 1 cell | 1 cell | 1 cell | 2 cell |
| Input MUX control | Dual input power MUX control | Single OVPFET | Single OVPFET | Dual input power MUX control |
| Bypass Mode | Yes | No | No | Yes |
| Recommended 8-A charging current | 8 A | 8 A | 6 A | 8 A |

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7 Pin Configuration and Functions

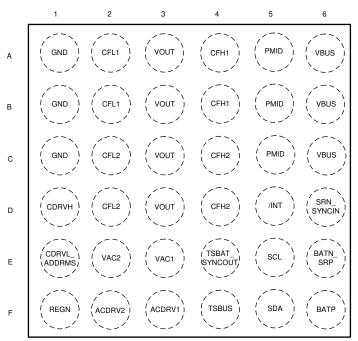


図 7-1. YBG Package - BQ25960 36-Pin DSBGA Top View

表 7-1. Pin Functions

| | PIN | TYPE(1) | DESCRIPTION |
|--------|---|---------|--|
| NO. | NAME | ITPE | DESCRIPTION |
| F3 | ACDRV1 | Р | Input FETs Driver Pin 1 - The charge pump output to drive the port #1 input N-channel MOSFET (ACFET1) and the reverse blocking N-channel MOSFET (RBFET1). ACDRV1 voltage becomes 5 V above the common drain connection of the ACFET1 and RBFET1, when the turn-on condition is met. If ACFET1 and RBFET1 are not used, connect ACDRV1 to ground. |
| F2 | MOSFET (ACFET2) and the reverse blocking N-channel MOSFET (RBFET2). ACDRV2 voltage becomes 5 V above the common drain connection of the ACFET2 and RBFET2, the turn-on condition is met. If ACFET2 and RBFET2 are not used, connect ACDRV2 to ground. | | voltage becomes 5 V above the common drain connection of the ACFET2 and RBFET2, when the turn-on condition is met. If ACFET2 and RBFET2 are not used, connect ACDRV2 to |
| E6 | BATN_SRP | AI | Negative input for battery voltage sensing and positive input for battery current sensing- Connect to negative terminal of battery pack. It is also used for battery current sensing. Place RSNS (2 m Ω or 5 m Ω) between BATN_SRP and SRN_SYNCIN. Short BATN_SRP to SRN_SYNCIN together and place 100- Ω series resistance between pin and negative terminal if RSNS is not being used. |
| F6 | BATP | Al | Positive input for battery voltage sensing - Connect to positive terminal of battery pack. Place $100-\Omega$ series resistance between pin and positive terminal. |
| D1 | CDRVH | AIO | Charge pump for gate drive - Connect a 0.22-µF cap between CDRVH and CDRVL_ADDRMS. |
| E1 | CDRVL_ADDRMS | AIO | Charge pump for gate drive - Connect a 0.22-µF cap between CDRVH and CDRVL_ADDRMS. During Power ON Reset (POR), this pin is used to assign the address of the device and the mode of the device as Standalone, Primary, or Secondary. |
| A4, B4 | CFH1 | Р | Switched cap flying cap connection -Connect 1 to 3 22-µF caps in parallel between this pin and CFL1. |
| C4, D4 | CFH2 | Р | Switched cap flying cap connection -Connect 1 to 3 22-µF caps in parallel between this pin and CFL2. |
| A2, B2 | CFL1 | Р | Switched cap flying cap connection -Connect 1 to 3 22-µF caps in parallel between this pin and CFH1. |



表 7-1. Pin Functions (continued)

| PIN | TVDE(1) | DESCRIPTION | |
|---------------|--|--|--|
| NAME | TYPE | DESCRIPTION | |
| CFL2 | Р | Switched cap flying cap connection -Connect 1 to 3 22-µF caps in parallel between this pin and CFH2. | |
| ĪNT | DO | Open drain, active low interrupt output - Pull up to voltage with 10-k Ω resistor. Normally high, the device asserts low to report status and faults. $\overline{\text{INT}}$ is pulsed low for t_{INT} . | |
| GND | Р | Ground return | |
| PMID | Р | Input to the switched cap power stage -Connect 10-µF cap to PMID. | |
| REGN | АО | harger internal LDO output - Connect a 4.7-μF cap between this pin and GND. When in rimary/Secondary Mode, connect through 1-kΩ resistor to the TSBAT_SYNCOUT and RN_SYNCIN pins. Do not use REGN for any other function. | |
| SCL | DI | ² C interface clock - Pull up to 3.3 V with 10-kΩ resistor. | |
| SDA | DIO | I ² C interface data - Pull up to 3.3 V with 10-kΩ resistor. | |
| SRN_SYNCIN | AI | Negative input for battery current sensing - Place RSNS ($2 \text{ m}\Omega$ or $5 \text{ m}\Omega$) between SRN_SYNCIN and SRP. Short to SRP and SRN_SYNCIN together if not used. If configured as a secondary for dual charger configuration, this pin functions as SYNCIN, and connect to TSBAT_SYNCOUT of Primary, and connect a 1-k Ω pullup resistor to REGN. | |
| TSBAT_SYNCOUT | AI | Battery temperature voltage input and Primary Mode SYNCOUT - Requires external resistor divider, NTC, and voltage reference. See the TSBAT section for choosing the resister divider values. If the device is in Primary Mode, connect this pin to SRN_SYNCIN of the Secondary device. | |
| TSBUS | Al | BUS temperature voltage input - Requires external resistor divider, NTC, and voltage reference. See the TSBUS section for choosing the resister divider values. | |
| VBUS | Р | Device power input - Connect 1-µF capacitor from VBUS to GND. | |
| VOUT | Р | Device power output - Connect 22-µF capacitor from VOUT to GND. | |
| VAC1 | Al | VAC1 input detection - Connected to VBUS if ACFET1 and RBFET1 are not used. | |
| VAC2 | Al | VAC2 input detection - Connected to VBUS if ACFET2 and RBFET2 are not used. | |
| | NAME CFL2 INT GND PMID REGN SCL SDA SRN_SYNCIN TSBAT_SYNCOUT TSBUS VBUS VOUT VAC1 | NAME CFL2 P INT DO GND P PMID P REGN AO SCL DI SDA DIO SRN_SYNCIN AI TSBAT_SYNCOUT AI VBUS P VOUT P VAC1 AI | |

⁽¹⁾ Type: P = Power, AIO = Analog Input/Output, AI = Analog Input, DO = Digital Output, AO = Analog Output, DIO = Digital Input/Output

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8 Specifications

8.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | | MIN | MAX | UNIT |
|---------------------|---|------|-----|------|
| | VAC1, VAC2 (converter not switching) | -2 | 40 | V |
| | VBUS (converter not switching) | -2 | 20 | V |
| | PMID (converter not switching) | -0.3 | 20 | V |
| | ACDRV1, ACDRV2 | -0.3 | 30 | V |
| | CFL1, CFL2 | -0.3 | 7 | V |
| Voltage | CFH1 to VOUT, CFH2 to VOUT | -0.3 | 7 | V |
| | VOUT | -0.3 | 7 | V |
| | BATP, BATN_SRP | -0.3 | 6 | V |
| | INT, SDA, SCL, CDRVL_ADDRMS, SRN_SYNCIN, TSBAT_SYNCOUT, TSBUS | -0.3 | 6 | V |
| | CDRVH | -0.3 | 20 | V |
| Output Sink Current | INT | | 6 | mA |
| T _J | Junction temperature | -40 | 150 | °C |
| T _{stg} | Storage temperature | -55 | 150 | °C |

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Rating may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Condition. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

8.2 ESD Ratings

| | | | VALUE | UNIT |
|--------------------|-------------------------|--|-------|------|
| | | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾ | ±2000 | |
| V _(ESD) | Electrostatic discharge | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins ⁽²⁾ | ±250 | V |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

8.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| | | MIN | NOM | MAX | UNIT |
|----------------------|--------------------------------|-----|-----|-----|------|
| VAC1, VAC2 | Input voltage at VAC1 and VAC2 | | | 12 | V |
| VBUS | Input voltage at VBUS | | | 12 | V |
| PMID | Input voltage at PMID | | | 12 | V |
| PMID-CFH1, PMID-CFH2 | Voltage across QCH1, QCH2 | | | 6 | V |
| CFH1-VOUT, CFH2-VOUT | Voltage across QDH1, QDH2 | | | 6 | V |
| VOUT-CFL1, VOUT-CFL2 | Voltage across QCL1, QCL2 | | | 6 | V |
| CFL1, CFL2 | Voltage across QDL1, QDL2 | | | 6 | V |
| ICHG | Charging current | | | 8 | Α |
| T _A | Ambient temperature | -40 | | 85 | °C |
| T _J | Junction temperature | -40 | | 120 | °C |
| C _{CFLY} | Effective CFLY capacitance | 6.6 | 20 | | μF |
| C _{VBUS} | Effective VBUS capacitance | 0.2 | 1 | | μF |
| C _{PMID} | Effective PMID capacitance | 2 | 10 | | μF |



8.3 Recommended Operating Conditions (continued)

over operating free-air temperature range (unless otherwise noted)

| | | MIN | NOM | MAX | UNIT |
|-------------------|----------------------------|-----|-----|-----|------|
| C _{OUT} | Effective VOUT capacitance | 2 | 10 | | μF |
| C _{REGN} | Effective REGN capacitance | 1 | 4.7 | | μF |
| C _{DRV} | Effective DRV capacitance | 44 | 220 | | nF |

8.4 Thermal Information

| | | BQ25960 | |
|-----------------------|--|-------------|------|
| | THERMAL METRIC ⁽¹⁾ | YBG (DSBGA) | UNIT |
| | | 36 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance (JEDEC ⁽¹⁾) | 54.8 | °C/W |
| R _{0JC(top)} | Junction-to-case (top) thermal resistance | 0.2 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 12 | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter | 0.1 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 11.9 | °C/W |

⁽¹⁾ For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

8.5 Electrical Characteristics

VBUS=8V, VOUT=4V, T_J = -40°C to +85°C, and T_J = 25°C for typical values (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--------------------------|--|--|------|-----|------|------|
| QUIESCENT CURR | RENTS | | | | | |
| lo pat | | ADC disabled, charge disabled, VBUS, VAC1, and VAC2 not present, VBAT=4V | | 12 | 20 | μA |
| I _{Q_BAT} | Quiescent battery current | ADC enabled (slowest mode), charge disabled, VBUS, VAC1, and VAC2 not present, VBAT=4V | | 480 | 750 | μA |
| I _{Q_VAC} | Quiescent VAC current | ADC disabled, charge disabled, ACDRV disabled, EN_HIZ=1, VAC1 or VAC2 =8V | | 90 | | μΑ |
| | | ADC enabled, charge disabled, ACDRV enabled, VAC1 or VAC2= 8V | | 660 | | μΑ |
| INTERNAL THRES | HOLD | | | | | |
| V _{VACUVLOZ} | VAC rising threshold for active I ² C, no VOUT, no VBUS | VAC1 or VAC2 rising | 3.24 | 3.4 | 3.6 | V |
| V _{VACUVLO} | VAC falling threshold for I ² C stop working | VAC1 or VAC2 falling | 3.05 | 3.2 | 3.4 | V |
| V | VAC rising threshold to turn on ACFET-RBFET | VAC1 or VAC2 rising | 3.3 | 3.4 | 3.5 | V |
| V _{VACPRESENT} | VAC falling threshold to turn off ACFET-RBFET | VAC1 or VAC2 falling | 3.1 | 3.2 | 3.3 | ٧ |
| V _{VBUSUVLOZ} | VBUS rising threshold for active I ² C, no VOUT, no VAC | VBUS rising | 3.24 | 3.4 | 3.6 | ٧ |
| V _{VBUSUVLO} | VBUS falling threshold for I ² C stop working | VBUS falling | 2.65 | 2.8 | 2.95 | ٧ |
| V _{VBUSPRESENT} | VBUS rising threshold to allow user set CHG_EN =1 | VBUS rising | 3.3 | 3.4 | 3.5 | ٧ |
| | VBUS falling | VBUS falling | 3.1 | 3.2 | 3.3 | V |

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VBUS=8V, VOUT=4V, T_J = -40°C to +85°C, and T_J = 25°C for typical values (unless otherwise noted)

| PAI | RAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------------------------|--|--|-------|-------|--------|------|
| V _{VOUTUVLOZ} | VOUT rising threshold for active I ² C, no VAC, no VBUS | VOUT rising | 2.48 | 2.6 | 2.72 | V |
| Vvoutuvlo | VOUT falling threshold for I ² C stop working | VOUT falling | 2.25 | 2.4 | 2.55 | V |
| V _{VOUTPRESENT} | VOUT rising to threshold allow user set CHG_EN =1 | VOUT rising | 3.0 | 3.1 | 3.2 | V |
| | VOUT falling | VOUT falling | 2.9 | 3.0 | 3.1 | V |
| RESISTANCE | | | | | | |
| R _{ON_BLK} | VBUS to PMID resistance | VBUS=8V | | 6.1 | 10.5 | mΩ |
| R _{ON_CH1} | PMID to CFH1 resistance | PMID=8V | | 19.3 | 26.8 | mΩ |
| R _{ON_DH1} | CFH1 to VOUT resistance | CFLY=4V | | 11.4 | 16.8 | mΩ |
| R _{ON_CL1} | VOUT to CFL1 resistance | VOUT=4V | | 11.8 | 18 | mΩ |
| R _{ON_DL1} | CFL1 to GND resistance | CFLY=4V | | 12 | 18.3 | mΩ |
| R _{ON_CH2} | PMID to CFH2 resistance | PMID=8V | | 19.3 | 26.8 | mΩ |
| R _{ON_DH2} | CFH2 to VOUT resistance | CFLY=4V | | 11.4 | 16.8 | mΩ |
| R _{ON_CL2} | VOUT to CFL2 resistance | VOUT=4V | | 11.8 | 18 | mΩ |
| R _{ON_DL2} | CFL2 to GND resistance | CFLY=4V | | 12 | 18.3 | mΩ |
| R _{VBUS_PD} | VBUS pull down resistance | | | 5 | | kΩ |
| R _{VAC_PD} | VAC pull down resistance for both VAC1 and VAC2 | VAC=10V | | 125 | | Ω |
| PROTECTION AND ALAR | M THRESHOLD AND ACCURAC | Y | | | | • |
| V _{BATOVP_RANGE} | Battery over-voltage range | | 3.491 | | 4.759 | V |
| V _{BATOVP_STEP} | Typical battery over-voltage step | | | 9.985 | | mV |
| I _{BATP} | BATP leakage current | | | | 1.2 | μΑ |
| I _{BATN} | BATN leakage current | | | | 1 | nA |
| V _{BATOVP_ACC} | Battery over-voltage accuracy | VBATOVP = 4.390V | 4.346 | 4.390 | 4.434 | V |
| V _{OUTOVP_ACC} | VOUT over-voltage accuracy | VOUTOVP= 5V | 4.9 | 5 | 5.1 | V |
| I _{BATOCP_RANGE} | Battery over-current range | | 2.05 | | 8.7125 | Α |
| I _{BATOCP_STEP} | Typical battery over-current step | | | 102.5 | | mA |
| I _{BATOCP_ACC} | Battery over-current accuracy | IBATOCP=6.15A, RSNS=2m Ω T _J = -20°C - 85°C | 5.842 | 6.15 | 6.458 | Α |
| M | VDLIC averagellana name | Switched Cap Mode | 7 | | 12.75 | V |
| V _{BUSOVP_RANGE} | VBUS over-voltage range | Bypass Mode | 3.5 | | 6.5 | |
| V/ | T | Switched Cap Mode | | 50 | | mV |
| V _{BUSOVP_STEP} | Typical VBUS over-voltage step | Bypass Mode | | 25 | | mV |
| | \/DUO | VBUSOVP = 4.45V | 4.39 | 4.45 | 4.488 | V |
| V _{BUSOVP_ACC} | VBUS over-voltage accuracy | VBUSOVP = 9V | 8.91 | 9 | 9.09 | V |
| V _{BUS_ERRHI_RISING_SC} | VBUS ERRHI rising threshold for switched cap mode stop switching | VOUT=4V | | 9.6 | | ٧ |
| V _{BUS_ERRHI_FALLING_SC} | VBUS ERRHI falling threshold for switched cap mode start switching | VOUT=4V | | 9.4 | | ٧ |
| V _{BUS_ERRHI_RISING_BYPASS} | VBUS ERRHI rising threshold for bypass mode stop switching | VOUT=4V | | 4.8 | | ٧ |
| V _{BUS_ERRHI_FALLING_BYPASS} | VBUS ERRHI falling threshold for bypass mode start switching | VOUT=4V | | 4.68 | | V |



VBUS=8V, VOUT=4V, T_J = -40°C to +85°C, and T_J = 25°C for typical values (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------------------|--|--|--------|--------|-------|------|
| V _{VACOVP_RANGE} | VAC over-voltage range | | 6.5 | | 18 | V |
| | | VACOVP=6.5V | 6.3 | 6.5 | 6.6 | V |
| V _{VACOVP_ACC} | VAC over-voltage accuracy | VACOVP=10.5V | 10.2 | 10.5 | 10.7 | V |
| _ | | VACOVP=12V | 11.7 | 12 | 12.2 | V |
| V _{VACOVP_HYS} | VACOVP hysteresis | | | 3 | | % |
| <u> </u> | | Switched Cap Mode | 1.0175 | | 4.579 | Α |
| BUSOCP_RANGE | Input over-current range | Bypass Mode | 1.0475 | | 6.809 | Α |
| | | Switched Cap Mode | | 254 | | mA |
| BUSOCP_STEP | Typical input over current step | Bypass Mode | | 262 | | mA |
| I _{BUSOCP_ACC} | Input over current accuracy | IBUSOCP=3.05A, switched cap mode T _J = -20°C - 85°C | 2.897 | 3.05 | 3.206 | А |
| | | IBUSOCP=3.14A, bypass mode $T_J = -20$ °C - 85°C | 2.983 | 3.14 | 3.297 | Α |
| I _{BUSUCP_ACC} | Input under-current accuracy | BUSUCP=250mA, $T_J = -20$ °C - 85°C | 100 | 250 | 450 | mA |
| I _{BUSRCP_ACC} | Input reverse-current accuracy | BUSRCP=300mA, T _J = -20°C - 85°C | 150 | 300 | 450 | mA |
| TS _{BUS_FLT_RANGE} | TSBUS fault % of V _{REGN} range | | 0 | | 50 | % |
| TS _{BUS_FLT_STEP} | TSBUS fault % of V _{REGN} step size | | | 0.1953 | | % |
| TS _{BUSFLT_ACC} | TSBUS fault accuracy | TSBUS_FLT=20.12% | 18.5 | 20.12 | 21.5 | % |
| TS _{BAT_FLT_RANGE} | TSBAT fault % of V _{REGN} range | | 0 | | 50 | % |
| TS _{BAT_FLT_STEP} | TSBAT fault % of V _{REGN} step size | | | 0.1953 | | % |
| TS _{BAT_FLT_ACC} | TSBAT voltage accuracy | TSBAT_FLT=20.12% | 18.5 | 20.12 | 21.5 | % |
| T _{DIE_FLT_RANGE} | TDIE over-temperature range | | 80 | | 140 | °C |
| T _{DIE_FLT_STEP} | TDIE over-temperature step | | | 20 | | °C |
| T _{DIE_ALM_RANGE} | TDIE over-temperature alarm range | | 25 | | 150 | °C |
| T _{DIE_ALM_STEP} | TDIE over-temperature alarm step | | | 0.5 | | °C |
| ADC MEASUREMEN | T PERFORMANCE | | | | | |
| | | ADC_SAMPLE[1:0] = 00 | | 24 | | ms |
| 4 | Conversion-time, Each | ADC_SAMPLE[1:0] = 01 | | 12 | | ms |
| ^L ADC_CONV | Measurement | ADC_SAMPLE[1:0] = 10 | | 6 | | ms |
| | | ADC_SAMPLE[1:0] = 11 | | 3 | | ms |
| | | ADC_SAMPLE[1:0] = 00 | 14 | 15 | | bit |
| ADC _{RES} | Effective Resolution | ADC_SAMPLE[1:0] = 01 | 13 | 14 | | bit |
| | Ellective Resolution | ADC_SAMPLE[1:0] = 10 | 12 | 13 | | bit |
| | | ADC_SAMPLE[1:0] = 11 | 10 | 11 | | bit |
| ADC MEASUREMEN | T RANGES AND ACCURACY | | | | | |
| I _{BUSADC_RANGE} | ADC BUS current range | | 0 | | 7 | Α |
| 1 | ADC BUS current LSB | Switched Cap Mode | | 0.9972 | | mA |
| IBUSADC_LSB | ADC BUS current LSB | Bypass Mode | | 1.0279 | | mA |
| 1 | ADC BUS current offset | Switched Cap Mode | | 66 | | mA |
| BUSADC_OFFSET | ADC BUS current offset | Bypass Mode | | 64 | | mA |

English Data Sheet: SLUSE08



VBUS=8V, VOUT=4V, T_J = -40°C to +85°C, and T_J = 25°C for typical values (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------------------|---|---|--------------|--------|--------------|------|
| 1 | ADC BUS current accuracy | IBUS=2A, ADC_SAMPLE[1:0]=00, T _J = -20°C - 85°C | 1.9 | 2 | 2.1 | Α |
| IBUSADC_ACC | ADC BOS current accuracy | IBUS=3A, ADC_SAMPLE[1:0]=00, T _J = -20°C - 85°C | 2.85 | 3 | 3.15 | Α |
| V _{BUSADC_RANGE} | ADC BUS voltage range | | 0 | | 16.39 | V |
| V _{BUSADC_LSB} | ADC BUS voltage LSB | | | 1.002 | | mV |
| Vallanda naa | ADC BUS voltage accuracy | VBUS=4V, ADC_SAMPLE[1:0]=00 | 3.96 | 4 | 4.04 | V |
| V _{BUSADC_ACC} | ADC BOO voltage accuracy | VBUS=8V, ADC_SAMPLE[1:0]=00 | 7.92 | 8 | 8.08 | V |
| V _{AC1ADC_RANGE} | ADC VAC1 voltage range | | 0 | | 14 | V |
| V _{AC1ADC_STEP} | ADC VAC1 voltage LSB | | | 1.0008 | | mV |
| V _{AC1ADC_OFFSET} | ADC VAC1 voltage offset | | | 3 | | mV |
| V _{AC1ADC_ACC} | ADC VAC1 voltage accuracy | VAC1=4V, ADC_SAMPLE[1:0]=00 VAC1=8V, ADC_SAMPLE[1:0]=00 | 3.96 7.92 | 8 | 4.04 8.08 | V |
| V _{AC2ADC_RANGE} | ADC VAC2 voltage range | | 0 | | 14 | V |
| V _{AC2ADC_LSB} | ADC VAC2 voltage LSB | | | 1.0006 | | mV |
| V _{AC2ADC_OFFSET} | ADC VAC2 voltage offset | | | 5 | | mV |
| V _{AC2ADC_ACC} | ADC VAC2 voltage accuracy | VAC2=4V, ADC_SAMPLE[1:0]=00 | 3.96 | 4 | 4.04 | V |
| V _{AC2ADC_ACC} | ADC VAC2 voltage accuracy | VAC2=8V, ADC_SAMPLE[1:0]=00 | 7.92 | 8 | 8.08 | V |
| V _{BATADC_RANGE} | ADC BAT voltage range | | 0 | | 6 | V |
| V _{BATADC_LSB} | ADC BAT voltage LSB | | | 1.017 | | mV |
| V _{BATADC_OFFSET} | ADC BAT voltage offset | | | 1 | | mV |
| V _{BATADC_ACC} | | VBAT=4V, ADC_SAMPLE[1:0]=00 | 3.96 | 4 | 4 4.04 | V |
| | ADC BAT voltage accuracy | VBAT=4.4V, ADC_SAMPLE[1:0]=00 | 4.356 | 4.4 | 4.444 | V |
| V _{OUTADC_RANGE} | ADC VOUT voltage range | | 0 | | 6 | V |
| V _{OUTADC_LSB} | ADC VOUT voltage LSB | | | 1.0037 | | mV |
| V _{OUTADC_OFFSET} | ADC VOUT voltage offset | | | 2 | | mV |
| | ADOMOLIT | VOUT=4V, ADC_SAMPLE[1:0]=00 | 3.98 | 4 | 4.02 | V |
| Voutadc_acc | ADC VOUT voltage accuracy | VOUT=4.4V, ADC_SAMPLE[1:0]=00 | 4.378 | 4.4 | 4.422 | V |
| I _{BATADC_RANGE} | ADC battery current range | | -12 | | 12 | Α |
| I _{BATADC_LSB} | ADC battery current LSB | | | 0.999 | | mA |
| I _{BATADC_OFFSET} | ADC battery current offset | | | -150 | | mA |
| | ADC battery current accuracy | IBAT=4A, ADC_SAMPLE[1:0]=00, T _J = -20°C - 85°C | 3.92 | 4.00 | 4.08 | Α |
| BATADC_ACC_2mOhm | through 2mOhm sense resistor | IBAT=6A, ADC_SAMPLE[1:0]=00, T _J = -20°C - 85°C | 5.88 | 6.00 | 6.12 | Α |
| TS _{BUSADC_RANGE} | ADC TSBUS % of V _{REGN} range | | 0 | | 50 | % |
| TS _{BUSADC_STEP} | ADC TSBUS % of V _{REGN} range LSB | | | 0.0986 | | % |
| TS _{BUSADC_OFFSET} | ADC TSBUS % of V _{REGN} range offset | | | 0.1 | | % |
| TS _{BUSADC_ACC} | ADC TSBUS accuracy | TSBUS=20% of V _{REGN} , ADC_SAMPLE[1:0]=00 | 19 | 20 | 21 | % |
| TS _{BATADC_RANGE} | ADC TSBAT % of V _{REGN} range | | 0 | | 50 | % |
| TS _{BATADC_STEP} | ADC TSBAT % of V _{REGN} range LSB | | | 0.0976 | | % |
| TS _{BATADC_OFFSET} | ADC TSBAT % of V _{REGN} range offset | | | 0.065 | | % |



VBUS=8V, VOUT=4V, T_J = -40°C to +85°C, and T_J = 25°C for typical values (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | CONDITIONS MIN TYP I | | MAX | UNIT |
|----------------------------|---|---|----------------------|--------|-----|------|
| TS _{BATADC_ACC} | ADC TSBAT accuracy | TSBAT=20% of V _{REGN} , ADC_SAMPLE[10]=00 | 19 | 20 | 21 | % |
| TDIE_ADC_RANGE | ADC TDIE range | | -40 | | 150 | °C |
| TDIE_ADC_STEP | ADC TDIE step | | | 0.5079 | | °C |
| TDIE_ADC_OFFSET | ADC TDIE offset | | | -3.5 | | °C |
| REGN LDO | | | | | | |
| V _{REGN} | REGN LDO output voltage | V _{BUS} =8V, I _{REGN} =20mA | | 5.0 | | V |
| I _{REGN} | REGN LDO current limit | V _{BUS} =8V, V _{REGN} =4.5V | 40 | | | mA |
| I2C INTERFACE (SCI | L, SDA) | | | | | |
| V _{IH} | Input high threshold level, SDA and SCL | Pull up rail 1.8V | 1.3 | | | V |
| V _{IL} | Input low threshold level | Pull up rail 1.8V | | | 0.4 | V |
| V _{OL} | Output low threshold level | Sink current = 5mA | | , | 0.4 | V |
| I _{BIAS} | High-level leakage current | Pull up rail 1.8V | | | 1 | μΑ |
| LOGIC OUTPUT PIN | (INT, TSBAT_SYNCOUT) | | | | | |
| V _{OL} | Output low threshold level, INT pin | Sink current = 5mA | | | 0.4 | ٧ |
| I _{OUT} | High-level leakage current, INT pin | Pull up rail 1.8V | | | 1 | μΑ |
| LOGIC INPUT PIN (S | RN_SYNCIN) | | | | | |
| V _{IH_SRN_SYNCIN} | Input high threshold level, SRN_SYNCIN | | 1.3 | | | V |
| V _{IL_SRN_SYNCIN} | Input low threshold level, SRN_SYNCIN | | | | 0.4 | ٧ |
| I _{IN_SRN_SYNCIN} | High level leakage current | Pull-up rail 1.8V | | | 1 | μΑ |

8.6 Timing Requirements

| o.o i iiiiiiig ixc | quironico | | | | |
|---------------------------|--|-----|-----|------|------|
| | | MIN | NOM | MAX | UNIT |
| TIMINGS | | | | | |
| t _{VACOVP} | VAC OVP response time | | 100 | | ns |
| t _{BATOCP} | IBAT OCP response time | | 640 | | μs |
| t _{INT} | Duration that INT is pulled low when an event occurs | | 256 | | μs |
| t _{ALM_DEBOUNCE} | Time between consecutive faults for ALM indication | | 120 | | ms |
| I2C INTERFACE | | | | | |
| f _{SCL} | SCL clock frequency | | | 1000 | kHz |

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8.7 Typical Characteristics

Typical characteristics are taken with the BMS041 for switching test and GRM188R61C226M is used as CFLY.

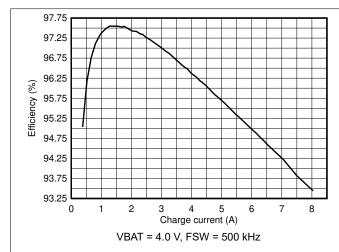


図 8-1. Battery Charge Efficiency vs. Charge Current, 1 x 22-μF CFLY per Phase Switching Frequency

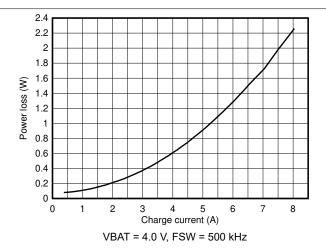


図 8-2. Battery Charge Power Loss vs. Charge Current, 1 x 22µF CFLY per Phase Switching Frequency

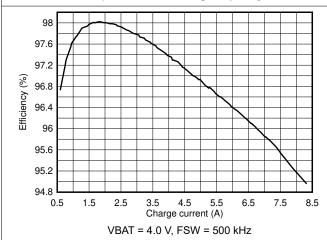


図 8-3. Battery Charge Efficiency vs. Charge Current, 2 x 22-µF CFLY per Phase

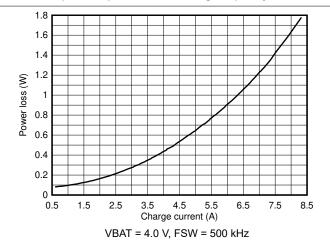


図 8-4. Battery Charge Power Loss vs. Charge Current, 2 x 22μF CFLY per Phase



8.7 Typical Characteristics (continued)

Typical characteristics are taken with the BMS041 for switching test and GRM188R61C226M is used as CFLY.

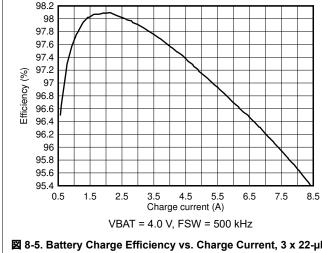


図 8-5. Battery Charge Efficiency vs. Charge Current, 3 x 22-µF **CFLY** per Phase

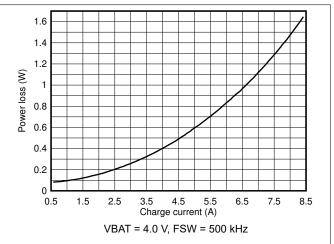


図 8-6. Battery Charge Power Loss vs. Charge Current, 3 x 22μF CFLY per Phase



9 Detailed Description

9.1 Overview

The BQ25960 is a 98.1% peak efficiency, 8-A battery charging solution using a switched cap architecture for 1-cell Li-ion battery. This architecture allows the cable current to be half the charging current, reducing the cable power loss, and limiting temperature rise. The dual-phase architecture increases charging efficiency and reduces the input and output cap requirements. When used with a main charger such as BQ2561x or BQ2589x, the system enables full charging cycle from trickle charge to termination with low power loss at Constant Current (CC) and Constant Voltage (CV) mode.

The device also operates in bypass mode charging the battery directly from VBUS through QB, QCH1 and QDH1 in parallel with QCH2 and QDH2. The impedance in bypass mode is limited to 21 m Ω for 5-A charging current.

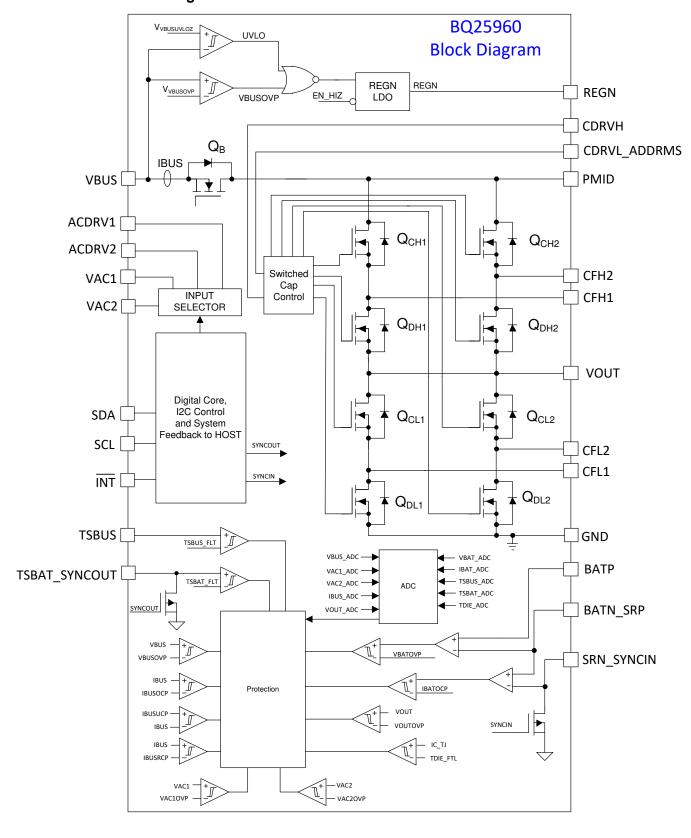
The device supports dual input power path management which manages the power flowing from two different input sources. The inputs selection is controlled by host through I²C with default source #1 as the primary input and the source #2 as the secondary source.

The device integrates all the necessary protection features to ensure safe charging, including input overvoltage and overcurrent protection, output overvoltage and overcurrent protection, temperature sensing for the battery and cable, and monitoring the die temperature.

The device includes a 16-bit ADC to provide bus voltage, bus current, output voltage, battery voltage, battery current, input connector temperature, battery temperature, junction temperature, and other calculated measurements needed to manage the charging of the battery from the smart wall adapter or wireless input or power bank.



9.2 Functional Block Diagram



English Data Sheet: SLUSE08



9.3 Feature Description

9.3.1 Charging System

BQ25960 is a single-cell high efficiency switched cap charger, used in parallel with a switching mode charger. A host must set up the protections and alarms on BQ25960 prior to enabling the BQ25960. The host must monitor the alarms generated by BQ25960 and communicate with the smart adapter to control the current delivered to the charger.

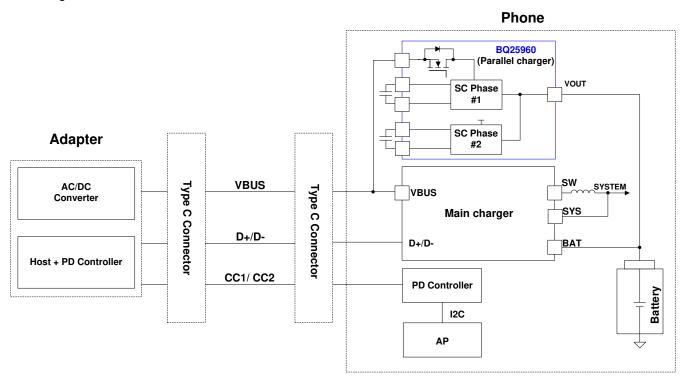


図 9-1. BQ25960 System Diagram

9.3.2 Battery Charging Profile

The system will have a specific battery charging profile that is unique due to the switched cap architecture. The charging will be controlled by the main charger such as the BQ2561x or BQ2589x until ystem voltage reaches minimum system regulation voltage V_{SYSMIN} . Once the battery voltage reaches V_{SYSMIN} (3.5 V), the adapter can negotiate for a higher bus voltage, enable BQ25960 charging, and regulate the current on VBUS to charge the battery. In the CC phase, the protection in BQ25960 will not regulate the battery voltage, but will provide feedback to the system to increase and decrease current as needed, as well as disable the blocking and switching FETs if the voltage is exceeded. Once the CV point is reached, the BQ25960 will provide feedback to the adapter to reduce the current, effectively tapering the current until a point where the main charger takes over again. The BQ25960 can operate as long as input current is above the BUSUCP threshold.

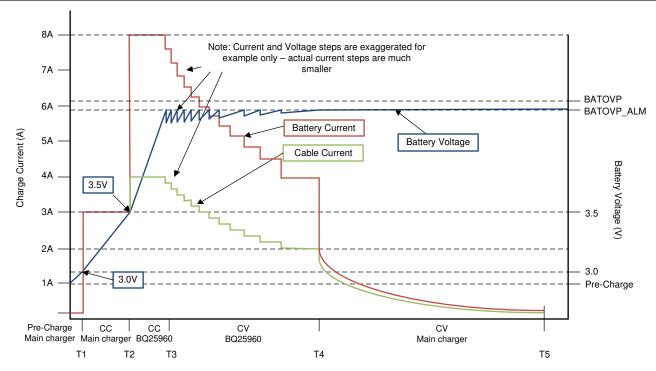


図 9-2. BQ25960 System Charging Profile

9.3.3 Device Power Up

The device is powered from the higher of VAC1 or VAC2 (with VAC1 being primary input), VBUS or VOUT (battery). The voltage must be greater than the $V_{VACUVLOZ}$, $V_{VBUSUVLOZ}$ or $V_{VOUTUVLOZ}$ threshold to be a valid supply. When VAC1 or VAC2 rises above $V_{VACUVLOZ}$ or VBUS rises above $V_{VBUSUVLOZ}$ or VOUT rises above $V_{VOUTUVLOZ}$, I²C interface is ready for communication and all the registers are reset to default value. The host needs to wait VBUSPRESENT_STAT and VOUTPRESENT_STAT go high before setting CHG_EN =1 and start charging.

9.3.4 Device HIZ State

The device enters HIZ mode when EN_HIZ bit is set to '1'. When device is in HIZ mode, the converter stops switching, ADC stops converting, ACDRV is turned off and REGN LDO is forced off even when the adapter is present and no fault condition is present. The device exits HIZ Mode when EN_HIZ is set to '0' by host or device POR.

The faults conditions force the converter stop switching and clear CHG_EN bit, but keep REGN on and EN_HIZ bit = 0. More details can be found in the Device Protection section.

9.3.5 Dual Input Bi-Directional Power Path Management

The device has two ACDRV pins to drive two sets of N-channel ACFET-RBFET, which select and manage the input power from two different input sources. In the POR sequence, the device detects if the ACFET-RBFET is populated based on if ACDRV pin is shorted to ground or not, and then updates the status register ACRB1_CONFIG_STAT or ACRB2_CONFIG_STAT to indicate the presence of ACFET-RBFET. If the external ACFET-RBFET is not populated in the schematic, then tie VAC to VBUS and connect ACDRV to GND. The device supports:

- single input without external FET
- 2. single input with one single ACFET
- dual input with one set of ACFET-RBFET
- 4. dual input with two sets of ACFET-RBFET

The power-up sequences for different applications are described in detail below.



9.3.5.1 ACDRV Turn-On Condition

The ACDRV controls input power MUX for both BQ25960 and main charger. In order to turn the ACDRV, all of the following conditions must be valid:

- The corresponding AC-RB FET is populated: VAC is not short to VBUS and ACDRV is not short to ground
- 2. VAC is above V_{VACpresent} threshold
- 3. VAC is below V_{VACOVP} threshold
- 4. DIS_ACDRV_BOTH is not set to '1'
- 5. EN HIZ is not set to '1'
- 6. VBUS is below V_{VBUSpresent} threshold

9.3.5.2 Single Input from VAC to VBUS without ACFET-RBFET

In this scenario, VAC1 and VAC2 are both shorted to VBUS, ACDRV1 and ACDRV2 are pulled down to ground. The table below summarizes the VAC1/VAC2, ACDRV1/ACDRV2 connection, register control, and status functions.

| 32 3-1. Onigie input without External I E1 Cultimary | | | |
|--|-----------------------------------|--|--|
| INPUT CONFIGURATION | SINGLE INPUT | | |
| External FET connection | No external FET | | |
| Input pin connection | VAC1 and VAC2 short to VBUS | | |
| ACDRV pin connection | ACDRV1 and ACDRV2 short to ground | | |
| ACDRV1_STAT | 0 | | |
| ACDRV2_STAT | 0 | | |
| DIS_ACDRV_BOTH | 1 | | |
| ACRB1_CONFIG_STAT | 0 | | |
| ACRB2_CONFIG_STAT | 0 | | |
| EN_HIZ | No impact on ACDRV | | |

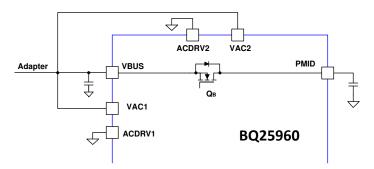


図 9-3. Single input without ACFET-RBFET

9.3.5.3 Single Input with ACFET1

In this scenario, ACFET1 without RBFET1 is populated, but ACFET2-RBFET2 is not. VAC2 is short to VBUS and ACDRV2 is pulled down to ground. The table below summarizes the VAC1/ VAC2, ACDRV1/ACDRV2 connection, register control, and status functions. Use VAC1 for single input configuration.

表 9-2. Single Input with Single ACFET1

| INPUT CONFIGURATION | SINGLE INPUT |
|-------------------------|--|
| External FET connection | ACFET1, no ACFET2-RBFET2 |
| Input pin connection | VAC1 connected to input source VAC2 short to VBUS |
| ACDRV pin connection | ACDRV1 active ACDRV2 tie to ground |

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表 9-2. Single Input with Single ACFET1 (continued)

| 20 21 chilgie input that enigle / tel 21 1 (continuou) | | | | |
|--|--|--|--|--|
| INPUT CONFIGURATION | SINGLE INPUT | | | |
| ACDRV1_STAT | 1: ACDRV1 is ON 0: ACDRV1 is OFF | | | |
| ACDRV2_STAT | 0 | | | |
| DIS_ACDRV_BOTH | 0: Allow ACDRV1 to turn on if the conditions of ACDRV turn on are met. 1: Force ACDRV1 OFF | | | |
| ACRB1_CONFIG_STAT | 1 | | | |
| ACRB2_CONFIG_STAT | 0 | | | |
| EN_HIZ | 0: Allow ACDRV1 to turn on if the conditions of ACDRV turn on are met. 1: Force ACDRV1 OFF | | | |

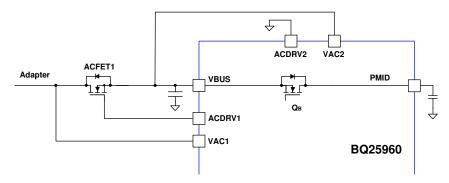


図 9-4. Single Input with ACFET1

9.3.5.4 Dual Input with ACFET1-RBFET1

In this scenario, ACFET1-RBFET1 is populated, but ACFET2-RBFET2 is not. VAC2 is short to VBUS and ACDRV2 is pulled down to ground. The table below summarizes the connection, register control and status functions. Use VAC1 for adapter input and VBUS for wireless input.

表 9-3. Dual Input with ACFET1-RBFET1

| INPUT CONFIGURATION | DUAL INPUT |
|-------------------------|---|
| External FET connection | ACFET1-RBFET1, no ACFET2-RBFET2 |
| Input pin connection | VAC1 connected to input source 1 VAC2 short to VBUS |
| ACDRV pin connection | ACDRV1 active ACDRV2 short to ground |
| ACDRV1_STAT | 0: ACDRV1 OFF 1: ACDRV1 ON |
| ACDRV2_STAT | 0 |
| DIS_ACDRV_BOTH | 0: Allow ACDRV1 to turn on if other conditions of ACDRV turn on are met 1: Force ACDRV1 OFF |
| ACRB1_CONFIG_STAT | 1 |
| ACRB2_CONFIG_STAT | 0 |
| EN_HIZ | 0: Allow ACDRV1 to turn on if other conditions of ACDRV turn on are met 1: Force ACDRV1 OFF |

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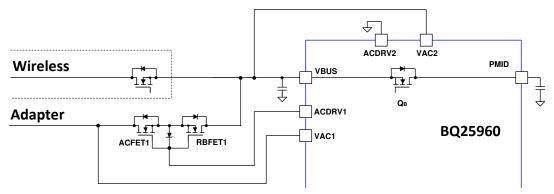


図 9-5. Dual Input with ACFET-RBFET1

9.3.5.5 Dual Input with ACFET1-RBFET1 and ACFET2-RBFET2

In this scenario, both ACFET1-RBFET1 and ACFET2-RBFET2 are populated and the device supports dual input. The table below summarizes the connection, register control and status functions. Connect input with high OVP threshold to VAC1.

表 9-4. Dual Input with Both ACFET1-RBFET1 and ACFET2-RBFET2 Summary

| INPUT CONFIGURATION | DUAL INPUT |
|-------------------------|--|
| External FET connection | ACFET1-RBFET1, ACFET1-RBFET2 |
| Input pin connection | VAC1 connected to input source 1 |
| | VAC2 connected to input source 2 |
| | No input source allowed to connect to VBUS |
| ACDRV pin connection | ACDRV1 and ACDRV2 active |
| ACDRV1_STAT | 0: ACDRV1 OFF |
| | 1: ACDRV1 ON |
| | Once device is in dual input configuration with ACFET1-RBFET1 and ACFET2-RBFET2, the |
| | host can use this bit to swap the input between VAC1 and VAC2 if both VAC1 and VAC2 are |
| | valid. |
| ACDRV2_STAT | 0: ACDRV2 OFF |
| | 1: ACDRV2 ON |
| | Once device is in dual input configuration with ACFET1-RBFET1 and ACFET2-RBFET2, the |
| | host can use this bit to swap the input between VAC1 and VAC2 if both VAC1 and VAC2 are |
| | valid. |
| DIS_ACDRV_BOTH | 0: Allow ACDRV to turn on. By default, ACDRV1 is turned on if the conditions of ACDRV turn |
| | on are met, ACDRV1_STAT=1 and ACDRV2_STAT =0. In On-The-GO (OTG) or Reverse TX |
| | Mode, refer to OTG and Reverse TX Mode Operation session for turn on precedence. |
| | 1: Force both ACDRV to turn off, both ACDRV1_STAT and ACDRV2_STAT become 0. |
| ACRB1_CONFIG_STAT | 1 |
| ACRB2_CONFIG_STAT | 1 |
| EN_HIZ | 0: Allow ACDRV to turn on for the port w/ VAC present if the conditions of ACDRV turn on |
| | are met. |
| | ACDRV1 is turned on since VAC1 is the primary input source when both VAC1 and VAC2 |
| | present and the turn on conditions are met. |
| | 1: Turns off both ACDRV |

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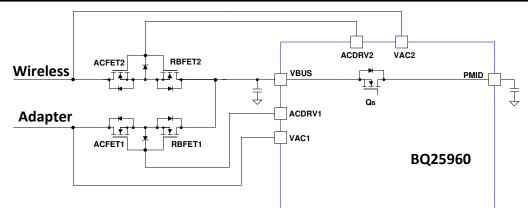


図 9-6. Two Inputs with ACFET-RBFET1 and ACFET-RBFET2

9.3.5.6 OTG and Reverse TX Mode Operation

When the main charger is in OTG or reverse TX Mode, the input power MUX (ACFET-RBFET) also controls which port is desired for OTG output.

To enter OTG or reverse TX Mode, the host should follow the steps below:

- 1. Host writes EN OTG =1
- 2. BQ25960 sets DIS ACDRV BOTH =1
- 3. Host writes DIS_ACDRV_BOTH=0, and then writes ACDRV1_STAT=1 or ACDRV2_STAT=1 depending on which port is desired for OTG or reverse TX output
- Host enables OTG Mode on main charger
- 5. If VBUSOVP or VACOVP fault occurs, ACDRV will be disabled but EN_OTG is still '1'. Host needs to write ACDRV1_STAT high or ACDRV2_STAT high when the fault is cleared. Set VAC10VP and VAC20VP to the same threshold in the OTG Mode
- 6. EN OTG is cleared when watchdog timer expires

To exit OTG or Reverse TX Mode, the host should follow the steps below:

- 1. Turn off main OTG or reverse TX source
- 2. Turn on VBUS pulldown resistor (R_{VBUS_PD}) by setting BUS_PD_EN=1 or VAC pulldown resistor R_{VAC_PD} by setting VAC1_PD_EN=1 or VAC2_PD_EN=1, depending on which port is to be discharged
- Wait for VBUS and VAC to be discharged
- 4. Turn off ACDRV by setting ACDRV1_STAT=0 or ACDRV2 STAT=0
- 5. Exit OTG Mode by setting EN OTG=0

9.3.6 Bypass Mode Operation

When host determines the adapter support bypass mode charging, the device can enable Bypass mode by setting EN_BYPASS=1. Blocking FET (Q_B) and four high side switching FET (QCH1 and QDH1/ QCH2 and QDH2) are turned on to charge from adapter to battery. During Bypass Mode, when fault occurs, CHG_EN is cleared but EN BYPASS stays '1'.

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English Data Sheet: SLUSE08



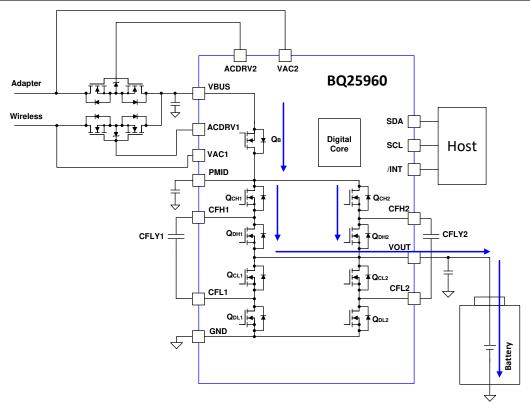


図 9-7. BQ25960 Bypass Mode

To change from Bypass Mode to Switched Cap Mode or from Switched Cap to Bypass Mode, the host would first set CHG_EN=0 to stop the converter and then set EN_BYPASS to desired value. The host sets desired protection threshold based on the selected operation modes and then host enables charge by setting CHG EN=1.

9.3.7 Charging Start-Up

The host can start Switched Cap or Bypass Mode charging follow the steps below:

- 1. Both VBUS and VOUT need to be present. Host can check the status through VBUSPRESENT_STAT (REG15[2]) and VOUTPRSENT_STAT (REG15[5]). Both of them need to be '1'.
- 2. Host sets all the protections to the desired thresholds. Refer to the Device Modes and Protection Status section for proper setting.
- 3. Host sets either Switched Cap Mode or Bypass Mode through EN_BYPASS bit (REG0F[3]) based on adapter type.
- 4. Host sets the desired switching frequency in Switched Cap Mode through FSW_SET [2:0] bits (REG10[7:5]).
- 5. Host sets BUS under current protection (BUSUCP) to 250 mA though BUSUCP bit (REG05[6])=1
- 6. Host sets charger configuration bits: CHG CONFIG 1 (REG05[3])=1.
- 7. Host can enable charge by setting CHG EN=1.
- 8. Once charge has been enabled, the CONV_ACTIVE_STAT bit is set to '1' to indicate either switched cap or bypass is active, and current starts to flow to the battery.
- 9. When watchdog timer expires, CHG_EN is reset to '0' and charging stops. Host needs to read or write any register bit before watchdog expires, or disable watchdog timer (set REG10[2]=1) to prevent watchdog timer from expiring.

9.3.8 Adapter Removal

If adapter is removed during soft start timer, CHG_EN will be cleared after soft-start timer expires. The user can program the soft-start timer in SS_TIMEOUT register. If adapter is removed after soft-start timer expires, converter stops switching and CHG_EN is cleared after the deglitch time programmed in



IBUSUCP_FALL_DG_SEL register. The device prevents boost back when the adapter is removed during and after the soft-start timer. To accelerate VBUS or VAC discharge after adapter removal, the user to turn on the VBUS pulldown resistor (R_{VBUS_PD}) and VAC pulldown current resistor (R_{VAC_PD}) by setting BUS_PD_EN or VAC1_PD_EN or VAC2_PD_EN to '1'.

9.3.9 Integrated 16-Bit ADC for Monitoring and Smart Adapter Feedback

The integrated 16-bit ADC of the device allows the user to get critical system information for optimizing the behavior of the charger control. The control of the ADC is done through the ADC control register. The ADC_EN bit provides the ability to enable and disable the ADC to conserve power. The ADC_RATE bit allows continuous conversion or one-shot behavior. The ADC_AVG bit enables or disables (default) averaging. ADC_AVG_INIT starts average using the existing (default) or using a new ADC value.

To enable the ADC, the ADC_EN bit must be set to '1'. The ADC is allowed to operate if the V_{VAC} > $V_{VACPRESENT}$, V_{VBUS} > V_{VBUS} PRESENT or V_{VOUT} > $V_{VOUTPRESENT}$ is valid. If ADC_EN is set to '1' before VAC, VBUS or VOUT reach their respective PRESENT threshold, then the ADC conversion will be postponed until one of the power supplies reaches the threshold.

The ADC_SAMPLE bits control the sample speed of the ADC, with conversion times of t_{ADC_CONV} . The integrated ADC has two rate conversion options: a 1-shot mode and a continuous conversion mode set by the ADC_RATE bit. By default, all ADC parameters will be converted in 1-shot or continuous conversion mode unless disabled in the ADC CONTROL 1 and ADC_CONTROL 2 register. If an ADC parameter is disabled by setting the corresponding bit in the ADC CONTROL 1 and ADC_CONTROL 2 register, then the value in that register will be from the last valid ADC conversion or the default POR value (all zeros if no conversions have taken place). If an ADC parameter is disabled in the middle of an ADC measurement cycle, the device will finish the conversion of that parameter, but will not convert the parameter starting the next conversion cycle. Even though no conversion takes place when all ADC measurement parameters are disabled, the ADC circuitry is active and ready to begin conversion as soon as one of the bits in the ADC CONTROL 1 and ADC_CONTROL 2 register is set to '0'.

The ADC_DONE_* bits signal when a conversion is complete in 1-shot mode only. During continuous conversion mode, the ADC_DONE_* bits have no meaning and will be '0'.

ADC conversion operates independently of the faults present in the device. ADC conversion will continue even after a fault has occurred (such as one that causes the power stage to be disabled), and the host must set ADC_EN = '0' to disable the ADC. ADC readings are only valid for DC states and not for transients. When host writes ADC_EN=0, the ADC stops immediately. If the host wants to exit ADC more gracefully, it is possible to do either of the following:

- 1. Write ADC_RATE to one-shot, and the ADC will stop at the end of a complete cycle of conversions, or
- 2. Write all the DIS bits low, and the ADC will stop at the end of the current measurement.

When external sense resistor (RSNS) is placed and IBATADC is used, it is recommended to use 375-kHz switching frequency.

9.3.10 Device Modes and Protection Status

 ${\it \pm}$ 9-5 shows the features and modes of the device depending on the conditions of the device.

STATE **BATTERY ONLY VAC1/** VAC2/ VBUS NOT **INPUT PRESENT** INPUT PRESENT **INPUT PRESENT FUNCTIONS AVAILABLE PRESENT DURING SOFTSTART** AFTER SOFTSTART **CHARGE DISABLED TIMER TIMER** I2C allowed Χ Χ ADC Χ Χ Χ Χ ACDRV gate drive Χ Х Χ

表 9-5. Device Modes and Protection Status

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表 9-5. Device Modes and Protection Status (continued)

| | STATE | | | | |
|---------------------|---|-----------------|---------------------------|--------------------------|--|
| FUNCTIONS AVAILABLE | BATTERY ONLY VAC1/ VAC2/ VBUS NOT PRESENT | INPUT PRESENT | INPUT PRESENT | INPUT PRESENT | |
| | | CHARGE DISABLED | DURING SOFTSTART TIMER | AFTER SOFTSTART TIMER | |
| VACOVP | | Х | X | X | |
| TDIE_ALM | | Х | X | Х | |
| TDIE_TFL | | Х | X | X | |
| BUSOVP_ALM | | | X | Х | |
| BUSOCP_ALM | | | X | X | |
| BATOVP_ALM | | | X | X | |
| BATOCP_ALM | | | X | X | |
| BATUCP_ALM | | | X | X | |
| VOUTOVP | | Х | X | X | |
| TSBUS_FLT | | Х | X | X | |
| TSBAT_ FLT | | Х | X | X | |
| BUSOVP | | Х | X | X | |
| BATOVP | | X | X | Х | |
| BATOCP | | | X | X | |
| BUSOCP | | | X | X | |
| BUSUCP | | | | X | |
| BUSRCP | | | X | X | |

Tripping any of these protections causes Q_B to be off and converter stops switching. Masking the fault or alarm does NOT disable the protection, but only keeps an $\overline{\text{INT}}$ from being triggered by the event. Disabling the fault or alarm protection other than BUSUCP holds that STAT and FLAG bits in reset, and also prevents an interrupt from occurring. Disable BUSUCP protection still sets STAT and FLAT bits and sends interrupt to alert host but keeps converter running when triggered.

When any OVP, OCP, RCP or overtemperature fault event is triggered, the CHG_EN bit is set to '0' to disable charging, and the charging start-up sequence must be followed to begin charging again.

9.3.10.1 Input Overvoltage, Overcurrent, Undercurrent, Reverse-Current and Short-Circuit Protection

Input overvoltage protection with external single or back-to-back N-channel FET(s): The device integrates the functionality of an input overvoltage protector. With external single or back-to-back N-channel FET(s), the device blocks high input voltage exceeding VACOVP threshold (VAC10VP or VAC20VP). This eliminates the need for a separate OVP device to protect the overall system. The integrated VACOVP feature has a response time of t_{VACOVP} (the actual time to turn off external FET(s) will be longer and depends upon the FET(s) gate capacitance). The VAC10VP and VAC20VP setting is adjustable in the VAC control register. The part allows the user to have different VAC10VP and VAC20VP settings. Always put the high VACOVP threshold input to VAC1.

When VAC10VP or VAC20VP is tripped, corresponding ACDRV is turned off and VAC10VP_STAT or VAC20VP_STAT and VAC10VP_FLAG or VAC20VP_FLAG is set to '1', and $\overline{\text{INT}}$ is asserted low to alert the host (unless masked by VAC10VP_MASK or VAC20VP_MASK). When VAC20VP is triggered, the device sends multiple interrupts when the fault persists. Use VAC1 as input unless both VAC1 and VAC2 are needed.

Input overvoltage protection (BUSOVP): The BUSOVP threshold is adjustable in the BUSOVP register. When BUSOVP is tripped, switched cap or bypass mode is disabled and CHG_EN is set to '0'. BUSOVP_STAT and BUSOVP_FLAG is set to '1', and $\overline{\text{INT}}$ is asserted low to alert the host (unless masked by BUSOVP_MASK). The start-up sequence must be followed to resume charging.



Input overcurrent protection (BUSOCP): Input overcurrent protection monitors the current flow into VBUS. The overcurrent protection threshold is adjustable in the BUSOCP register. When BUSOCP is tripped, Switched Cap or Bypass Mode is disabled and CHG_EN is set to '0'. BUSOCP_STAT and BUSOCP_FLAG is set to '1', and $\overline{\text{INT}}$ is asserted low to alert the host (unless masked by BUSOCP_MASK). The start-up sequence must be followed to resume charging.

Input undercurrent protection (BUSUCP): BUS undercurrent protection (UCP) is implemented to detect adapter unplug. Set BUSUCP =1 (REG05[6]) before enable charge. When BUSUCP is enabled (BUSUCP_DIS=0), if the current is below BUSUCP after soft start timer (programmable in SS_TIMEOUT[2:0]) expires, Switched Cap or Bypass Mode is disabled and CHG_EN is set to '0'. BUSUCP_STAT and BUSUCP_FLAG is set to '1', and $\overline{\text{INT}}$ is asserted low to alert the host (unless masked by BUSUCP_MASK). The start-up sequence must be followed to resume charging. The deglitch time for BUSUCP is programmable in IBUSUCP_FALL_DG_SET[1:0] register. Please note that BUSUCP deglitch time needs to be set shorter than soft start timer in order for BUSUCP to be effective.

When BUSUCP is disabled (BUSUCP_DIS=1), if the current is below BUSUCP after soft-start timer expires, CHG_EN is not set to '0', BUSUCP_STAT and BUSUCP_FLAG is set to '1', and INT is asserted low to alert the host (unless masked by BUSUCP_MASK). The host can determine if charge needs to be stopped in this case.

Input reverse-current protection (**BUSRCP**): The device monitors the current flow from VBUS to VBAT to ensure there is no reverse current (current flow from VBAT to VBUS). In an event that a reverse current flow is detected when BUSRCP_DIS is set to '0', the Switched Cap or Bypass is disabled and CHG_EN is set to '0'. The start-up sequence must be followed to resume charging. To disable BUSRCP, set REG05[1:0] to '00' and then set BUSRCP_DIS=1.

RCP is always active when converter is switching and BUSRCP_DIS is set to '0'. When RCP is tripped, BUSRCP_STAT and BUSRCP_FLAG is set to '1', and $\overline{\text{INT}}$ is asserted low to alert the host (unless masked by BUSRCP_MASK).

Input overvoltage and overcurrent protection alarm (BUSOVP_ALM and BUSOCP_ALM): In addition to input overvoltage and overcurrent, the device also integrates alarm function BUSOVP_ALM and BUSOCP_ALM. When alarm is triggered, the corresponding STAT and FLAG bit is set to '1' and INT is asserted low to alert the host (unless it is masked by the MASK bit). However, CHG_EN is not cleared and host can reduce input voltage or input current to prevent VBUS reaching VBUSOVP threshold or IBUS reaching IBUSOCP threshold.

VBUS_ERRHI: the device monitors VBUS to VOUT voltage ratio. If VBUS/VOUT is greater than V_{BUS_ERRHI_RISING} threshold, the converter does not switch but CHG_EN is kept at '1'. The converter automatically starts switching when the VBUS/VOUT drops below V_{BUS_ERRHI_FALLING} threshold.

9.3.10.2 Battery Overvoltage and Overcurrent Protection

BATOVP and **BATOVP_ALM**: The device integrates both overcurrent and overvoltage protection for the battery. The device monitors the battery voltage on BATP and BATN_SRP. In order to reduce the possibility of battery terminal shorts during manufacturing, $100-\Omega$ series resistors on BATP is required. If external sense resistor is not used, place $100-\Omega$ series resistors on BATN as well. The device is intended to be operated within the window formed by the BATOVP and BATOVP_ALM. When the BATOVP_ALM is reached, an interrupt is sent to the host to reduce the charge current and thereby not reaching the BATOVP threshold. If BATOVP is reached, the switched cap or bypass is disabled and CHG_EN is set to '0', and the start-up sequence must be followed to resume charging. At the same time, BATOVP_STAT and BATOVP_FLAG are set to '1', and $\overline{\text{INT}}$ is asserted low to alert the host (unless masked by BATOVP_MASK). BATOVP and BATOVP_ALM is disabled when BATOVP_DIS and BATOVP_ALM_DIS is set to '1'.

BATOCP and BATOCP_ALM: The device monitors current through the battery by monitoring the voltage across the external series battery sense resistor. The differential voltage of this sense resistor is measured on BATN_SRP and SRN_SYNCIN. The device is intended to be operated within the window formed by the BATOCP and BATOCP_ALM. When the BATOCP_ALM is reached, an interrupt is sent to the host to reduce the charge current from reaching the BATOCP threshold. If BATOCP is reached, the Switched Cap or Bypass is disabled after a deglitch time of t_{BATOCP} and CHG_EN is set to '0', and the start-up sequence must be followed to resume charging. At the same time, BATOCP_STAT and BATOCP_FLAG are set to '1', and INT is asserted

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low to alert the host (unless masked by BATOCP_MASK). BATOCP and BATOCP_ALM is disabled when BATOCP DIS and BATOCP ALM DIS is set to '1'.

VOUTOVP: The device also monitors output voltage between VOUT and ground in case of battery removal to protect the system. If VOUTOVP is reached and VOUTOVP_DIS=0, the Switched Cap or Bypass is disabled and CHG_EN is set to '0', and the start-up sequence must be followed to resume charging. At the same time, VOUTOVP_STAT and VOUTOVP_FLAG is set to '1', and $\overline{\text{INT}}$ is asserted low to alert the host (unless masked by VOUTOVP MASK). If VOUTOVP DIS =1, the protection is disabled.

9.3.10.3 IC Internal Thermal Shutdown, TSBUS, and TSBAT Temperature Monitoring

The device has three temperature sensing mechanisms to protect the device and system during charging:

- 1. TSBUS for monitoring the cable connector temperature
- TSBAT for monitoring the battery temperature
- TDIE for monitoring the internal junction temperature of the device

The TSBUS and TSBAT both rely on a resistor divider that has an external pullup voltage to REGN. Place a negative coefficient thermistor (NTC) in parallel to the low-side resistor. A fault on the TSBUS and TSBAT pin is triggered on the falling edge of the voltage threshold, signifying a "hot" temperature. The threshold is adjusted using the TSBUS FLT and TSBAT FLT registers.

The typical TS resistor network on TSBAT_SYNCOUT is illustrated in 🗵 9-8. The resistor network on TSBUS is the same.

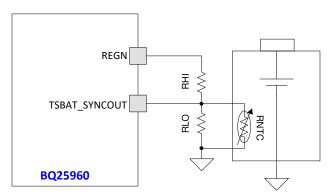


図 9-8. TSBAT_SYNCOUT Resistor Network

The RLO and RHI resistors should be chosen depending on the NTC used. If a $10-k\Omega$ NTC is used, use $10-k\Omega$ resistors for RLO and RHI. If a $100-k\Omega$ NTC is used, use $100-k\Omega$ resistors for RLO and RHI. The ratio of VTS/REGN can be from 0% to 50%, and the voltage at the TS pin is determined by the following equation.

$$TSBUS \ or \ TSBAT \ (V) = \frac{\frac{1}{(\frac{1}{RNTC} + \frac{1}{RLO})}}{RHI + \frac{1}{(\frac{1}{RNTC} + \frac{1}{RLO})}} \times VREGN$$
(1)

The percentage of the TS pin voltage is determined by the following equation.

TSBUS or TSBAT (%) =
$$\frac{\frac{1}{(\frac{1}{RNTC} + \frac{1}{RLO})}}{RHI + \frac{1}{(\frac{1}{RNTC} + \frac{1}{RLO})}}$$
(2)



Additionally, the device measures internal junction temperature, with adjustable threshold TDIE_FLT in TDIE FLT register.

If the TSBUS_FLT, TSBAT_FLT, and TDIE_FLT thresholds are reached, the Switched Cap or Bypass Mode is disabled and CHG_EN is set to '0', and the start-up sequence must be followed to resume charging. The corresponding STAT and FLAG bit is set to '1' unless it is masked by the MASK bit. If TSBUS, TSBAT, or TDIE protections are not used, the functions can be disabled in the register by setting the TSBUS_FLT_DIS, TSBAT_FLT_DIS, or TDIE_FLT_DIS bit to '1'.

TSBUS_TSBAT_ALM_STAT and FLAG is set to '1' unless it is masked by corresponding mask bit when one of the following conditions is met: 1) TSBUS is within 5% of TSBUS_FLT threshold or 2) TSBAT is within of TSBAT_FLT. If the TSBUS_FLT or TSBAT_FLT is disabled, it will not trigger a TSBUS_TSBAT_ALM interrupt. Using the TDIE_ALM register, an alarm can be set to notify the host when the device die temperature exceeds a threshold. The TDIE_ALM_STAT and TDIE_ALM_FLAG bit is set to '1' unless it is masked by TDIE_ALM_MASK bit. The device will not automatically stop switching when reaching the alarm threshold and the host may decide on the steps to take to lower the temperature, such as reducing the charge current.

9.3.11 INT Pin, STAT, FLAG, and MASK Registers

The $\overline{\text{INT}}$ pin is an open drain pin that needs to be pulled up to a voltage with a pullup resistor. $\overline{\text{INT}}$ is normally high and will assert low for t_{INT} when the device needs to alert the host of a fault or status change.

The fields in the STAT registers show the current status of the device, and are updated as the status changes. The fields in the FLAG registers indicate that the event has occurred, and the field is cleared when read. If the event persists after the FLAG register has been read and cleared, another $\overline{\text{INT}}$ signal is not sent to prevent host keep receiving interrupts. The fields in the MASK registers allow the user to disable the interrupt on the $\overline{\text{INT}}$ pin, but the STAT and FLAG registers are still updated even though $\overline{\text{INT}}$ is not pulled low.

9.3.12 Dual Charger Operation Using Primary and Secondary Modes

The dual charger can operate in Primary and Secondary Mode in Bypass Mode as well. In both Bypass and Switched Cap Mode, the current distribution between the two devices depends on loop impedance and the chargers do not balance it. In order balance the current, the board layout needs to be as symmetrical as possible.

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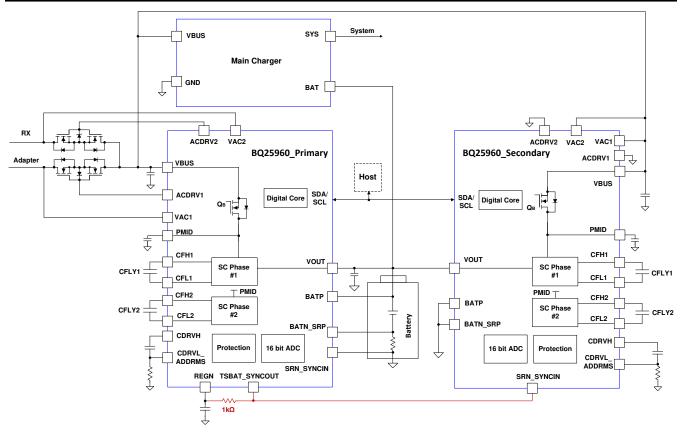


図 9-9. Parallel Operation of BQ25960

9.3.13 CDRVH and CDRVL_ADDRMS Functions

The device requires a cap between the CDRVH and CDRVL_ADDRMS pin to operate correctly. The CDRVL_ADDRMS pin also allows setting the default I^2C address and device operation mode. Pull to GND with a resistor for the desired setting shown in $\frac{1}{5}$ 9-6. The surface mount resistor with $\frac{1}{5}$ tolerance is recommended. After POR, the host can read back the device's configuration from MS register (REG12[1:0]).

| R_{ADDRMS} (k Ω) | I ² C ADDRESS | CONFIGURATION |
|----------------------------|--------------------------|--------------------------|
| >75.0 | 0x65 | Standalone |
| 6.19 | 0x67 | Standalone |
| 8.06 | 0x66 | Dual charger (Secondary) |
| 10.5 | 0x66 | Dual charger (Primary) |
| 14.0 | 0x66 | Standalone |
| 18.2 | 0x67 | Dual charger (Secondary) |
| 27.4 | 0x65 | Dual charger (Primary) |

表 9-6. I²C Address and Mode Selection

9.4 Programming

The device uses an I²C compatible interface to program and read many parameters. I²C is a 2-wire serial interface developed by NXP (formerly Philips Semiconductor, see I²C BUS Specification, Version 5, October 2012). The BUS consists of a data line (SDA) and a clock line (SCL) with pullup structures. When the BUS is idle, both SDA and SCL lines are pulled high. All the I²C compatible devices connect to the I²C BUS through open drain I/O terminals, SDA and SCL. A master device, usually a microcontroller or digital signal processor, controls the BUS. The master is responsible for generating the SCL signal and device addresses. The master



also generates specific conditions that indicate the START and STOP of data transfer. A slave device receives and/or transmits data on the BUS under control of the master device.

The device works as a slave and supports the following data transfer modes, as defined in the I²C BUS™ Specification: standard mode (100 kbps) and fast mode (400 kbps). The interface adds flexibility to the battery management solution, enabling most functions to be programmed to new values depending on the instantaneous application requirements. The I²C circuitry is powered from the battery in active battery mode. The battery voltage must stay above VBATUVLO when no VIN is present to maintain proper operation.

The data transfer protocol for standard and fast modes is exactly the same; therefore, they are referred to as the F/S-mode in this document. The device only supports 7-bit addressing. The device 7-bit address is determined by the ADDR pin on the device.

9.4.1 F/S Mode Protocol

The master initiates data transfer by generating a start condition. The start condition is when a high-to-low transition occurs on the SDA line while SCL is high, as shown in the figure below. All I²C-compatible devices should recognize a start condition.

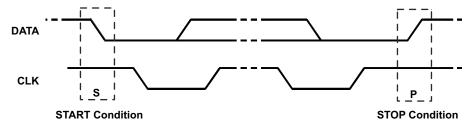


図 9-10. START and STOP Condition

The master then generates the SCL pulses, and transmits the 8-bit address and the read/write direction bit R/W on the SDA line. During all transmissions, the master ensures that data is valid. A valid data condition requires the SDA line to be stable during the entire high period of the clock pulse (see 29-11). All devices recognize the address sent by the master and compare it to their internal fixed addresses. Only the slave device with a matching address generates and acknowledge (see 29-12) by pulling the SDA line low during the entire high period of the ninth SCL cycle. Upon detecting this acknowledge, the master knows that communication link with a slave has been established.

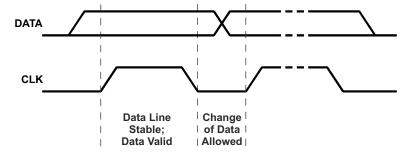


図 9-11. Bit Transfer on the Serial Interface

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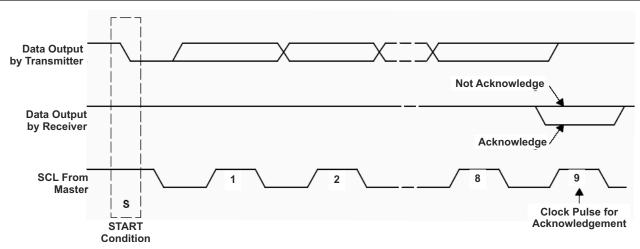


図 9-12. Acknowledge on the I²C BUS

The master generates further SCL cycles to either transmit data to the slave (R/W bit 0) or receive data from the slave (R/W bit 1). In either case, the receiver needs to acknowledge the data sent by the transmitter. An acknowledge signal can either be generated by the master or by the slave, depending on which on is the receiver. The 9-bit valid data sequences consisting of 8-bit data and 1-bit acknowledge can continue as long as necessary. To signal the end of the data transfer, the master generates a stop condition by pulling the SDA line from low to high while the SCL line is high (see \boxtimes 9-13). This releases the BUS and stops the communication link with the addressed slave. All I²C compatible devices must recognize the stop condition. Upon the receipt of a stop condition, all devices know that the BUS is released, and wait for a start condition followed by a matching address. If a transaction is terminated prematurely, the master needs to send a STOP condition to prevent the slave I²C logic from remaining in an incorrect state. Attempting to read data from register addresses not listed in this section will result in 0xFFh being read out.

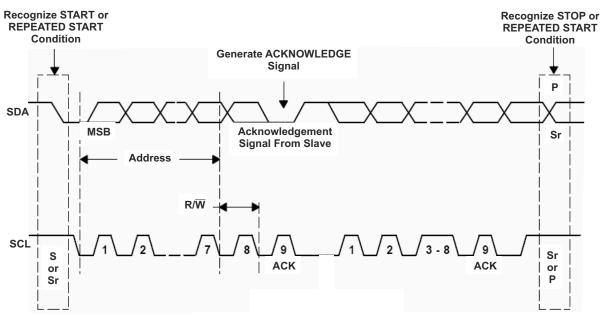


図 9-13. BUS Protocol



9.5 Register Maps

9.5.1 I²C Registers

 \pm 9-7 lists the I²C registers. All register offset addresses not listed in \pm 9-7 should be considered as reserved locations and the register contents should not be modified. All register bits marked 'RESERVED' in Field column should not be modified.

表 9-7. I²C Registers

| Offset | Acronym | Register Name | Section |
|--------|-------------------------|-------------------|---------|
| 0h | REG00_BATOVP | BATOVP | Go |
| 1h | REG01_BATOVP_ALM | BATOVP_ALM | Go |
| 2h | REG02_BATOCP | BATOCP | Go |
| 3h | REG03_BATOCP_ALM | BATOCP_ALM | Go |
| 4h | REG04_BATUCP_ALM | BATUCP_ALM | Go |
| 5h | REG05_CHARGER_CONTROL 1 | CHARGER_CONTROL 1 | Go |
| 6h | REG06_BUSOVP | BUSOVP | Go |
| 7h | REG07_BUSOVP_ALM | BUSOVP_ALM | Go |
| 8h | REG08_BUSOCP | BUSOCP | Go |
| 9h | REG09_BUSOCP_ALM | BUSOCP_ALM | Go |
| Ah | REG0A_TEMP_CONTROL | TEMP CONTROL | Go |
| Bh | REG0B_TDIE_ALM | TDIE_ALM | Go |
| Ch | REG0C_TSBUS_FLT | TSBUS_FLT | Go |
| Dh | REG0D_TSBAT_FLT | TSBAT_FLT | Go |
| Eh | REG0E_VAC_CONTROL | VAC CONTROL | Go |
| Fh | REG0F_CHARGER_CONTROL 2 | CHARGER CONTROL 2 | Go |
| 10h | REG10_CHARGER_CONTROL 3 | CHARGER CONTROL 3 | Go |
| 11h | REG11_CHARGER_CONTROL 4 | CHARGER CONTROL 4 | Go |
| 12h | REG12_CHARGER_CONTROL 5 | CHARGER CONTROL 5 | Go |
| 13h | REG13_STAT 1 | STAT 1 | Go |
| 14h | REG14_STAT 2 | STAT 2 | Go |
| 15h | REG15_STAT 3 | STAT 3 | Go |
| 16h | REG16_STAT 4 | STAT 4 | Go |
| 17h | REG17_STAT 5 | STAT 5 | Go |
| 18h | REG18_FLAG 1 | FLAG 1 | Go |
| 19h | REG19_FLAG 2 | FLAG 2 | Go |
| 1Ah | REG1A_FLAG 3 | FLAG 3 | Go |
| 1Bh | REG1B_FLAG 4 | FLAG 4 | Go |
| 1Ch | REG1C_FLAG 5 | FLAG 5 | Go |
| 1Dh | REG1D_MASK 1 | MASK 1 | Go |
| 1Eh | REG1E_MASK 2 | MASK 2 | Go |
| 1Fh | REG1F_MASK 3 | MASK 3 | Go |
| 20h | REG20_MASK 4 | MASK 4 | Go |
| 21h | REG21_MASK 5 | MASK 5 | Go |
| 22h | REG22_DEVICE_INFO | DEVICE INFO | Go |
| 23h | REG23_ADC_CONTROL 1 | ADC_CONTROL 1 | Go |
| 24h | REG24_ADC_CONTROL 2 | ADC_CONTROL 2 | Go |
| 25h | REG25_IBUS_ADC | IBUS_ADC | Go |
| 27h | REG27_VBUS_ADC | VBUS ADC | Go |



表 9-7. I²C Registers (continued)

| Offset | Acronym | Register Name | Section |
|--------|-----------------|---------------|---------|
| 29h | REG29_VAC1_ADC | VAC1_ADC | Go |
| 2Bh | REG2B_VAC2_ADC | VAC2_ADC | Go |
| 2Dh | REG2D_VOUT_ADC | VOUT_ADC | Go |
| 2Fh | REG2F_VBAT_ADC | VBAT_ADC | Go |
| 31h | REG31_IBAT_ADC | IBAT_ADC | Go |
| 33h | REG33_TSBUS_ADC | TSBUS_ADC | Go |
| 35h | REG35_TSBAT_ADC | TSBAT_ADC | Go |
| 37h | REG37_TDIE_ADC | TDIE_ADC | Go |

Complex bit access types are encoded to fit into small table cells. $\frac{1}{2}$ 9-8 shows the codes that are used for access types in this section.

表 9-8. I2C Access Type Codes

| 2000.1207.00000 1,700 00000 | | | | | | | |
|-----------------------------|------------------------|--|--|--|--|--|--|
| Access Type | Code | Description | | | | | |
| Read Type | | | | | | | |
| R | R | Read | | | | | |
| Write Type | | | | | | | |
| W | W | Write | | | | | |
| Reset or Default | Reset or Default Value | | | | | | |
| -n | | Value after reset or the default value | | | | | |

9.5.1.1 REG00_BATOVP Register (Offset = 0h) [reset = 5Ah]

REG00_BATOVP is shown in 表 9-9

Return to the Summary Table.

BATOVP

表 9-9. REG00 BATOVP Register Field Descriptions

| | 20 01112000_D7110111 11011 D00011ptionic | | | | | | | | |
|-----|--|------|-------|----------------------|--|--|--|--|--|
| Bit | Field | Туре | Reset | Note | Description | | | | |
| 7 | BATOVP_DIS | R/W | Oh | Reset by: REG_RST | Disable BATOVP Type: R/W POR: 0b 0h = Enable 1h = Disable | | | | |
| 6-0 | BATOVP_6:0 | R/W | 5Ah | Reset by: REG_RST | Battery Overvoltage Setting. When the battery voltage reaches the programmed threshold, Q_B and switching FETs are turned off and CHG_EN is set to '0'. The host controller should monitor the bus voltage to ensure that the adapter keeps the voltage under the BATOVP threshold for proper operation. Type: R/W POR: 4390 mV (5Ah) Range: 3491 mV - 4759 mV Fixed Offset: 3491 mV Bit Step Size: 9.985 mV | | | | |

Product Folder Links: BQ25960

9.5.1.2 REG01_BATOVP_ALM Register (Offset = 1h) [reset = 46h]

REG01_BATOVP_ALM is shown in 表 9-10.

Return to the Summary Table.



BATOVP_ALM

表 9-10. REG01_BATOVP_ALM Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|----------------|------|-------|----------------------|--|
| 7 | BATOVP_ALM_DIS | R/W | Oh | Reset by: REG_RST | Disable BATOVP_ALM Type : R/W POR: 0b 0h = Enable 1h = Disable |
| 6-0 | BATOVP_ALM_6:0 | R/W | 46h | Reset by: REG_RST | When battery voltage goes above the programmed threshold, an INT is sent. The BATOVP_ALM should be set lower than BATOVP and the host controller should monitor the battery voltage to ensure that the adapter keeps the voltage under BATOVP threshold for proper operation. Type: R/W POR: 4200 mV (46h) Range: 3500 mV - 4770 mV Fixed Offset: 3500 mV Bit Step Size: 10 mV |

9.5.1.3 REG02_BATOCP Register (Offset = 2h) [reset = 47h]

REG02_BATOCP is shown in 表 9-11.

Return to the Summary Table.

BATOCP

表 9-11. REG02_BATOCP Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|------------|------|-------|----------------------|---|
| 7 | BATOCP_DIS | R/W | 0h | Reset by: REG_RST | Disable BATOCP Type: R/W POR: 0b 0h = Enable 1h = Disable |
| 6-0 | BATOCP_6:0 | R/W | 47h | Reset by: REG_RST | Battery Overcurrent Protection Setting. When battery current reaches the programmed threshold, the Q_B and switching FETs are disabled and CHG_EN is set to '0'. The host controller should monitor the battery current to ensure that the adapter keeps the current under the threshold for proper operation. Type: R/W POR: 7277.5 mA (47h) Range: 2050 mA - 8712.5 mA Fixed Offset: 0 mA Bit Step Size: 102.5 mA |

9.5.1.4 REG03_BATOCP_ALM Register (Offset = 3h) [reset = 46h]

REG03_BATOCP_ALM is shown in 表 9-12.

Return to the Summary Table.

BATOCP_ALM

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表 9-12. REG03_BATOCP_ALM Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|----------------|------|-------|----------------------|--|
| 7 | BATOCP_ALM_DIS | R/W | 0h | Reset by: REG_RST | Disable BATOCP_ALM Type : R/W POR: 0b 0h = Enable 1h = Disable |
| 6-0 | BATOCP_ALM_6:0 | R/W | 46h | Reset by: REG_RST | Battery Overcurrent Alarm Setting. When battery current reaches the programmed threshold, an INT is sent. The BATOCP_ALM should be set lower than BATOCP and the host controller should monitor the battery current to ensure that the adapter keeps the current under BATOCP threshold for proper operation. Type: R/W POR: 7000 mA (46h) Range: 0 mA - 12700 mA Fixed Offset: 0 mA Bit Step Size: 100 mA |

9.5.1.5 REG04_BATUCP_ALM (Offset = 4h) [reset = 28h]

REG04_BATUCP_ALM is shown in 表 9-13.

Return to the Summary Table.

BATUCP_ALM

表 9-13. REG04_BATUCP_ALM Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|----------------|------|-------|----------------------|---|
| 7 | BATUCP_ALM_DIS | R/W | 0h | Reset by: REG_RST | Disable BATUCP_ALM Type: R/W POR: 0b 0h = Enable 1h = Disable |
| 6-0 | BATUCP_ALM_6:0 | R/W | 28h | Reset by: REG_RST | Battery Undercurrent Alarm setting. When battery current falls below the programmed threshold, an INT is sent. The host controller should monitor the battery current to determine when to disable the device and hand over charging to the main charger. Type: R/W POR: 2000 mA (28h) Range: 0 mA - 4500 mA Fixed Offset: 0 mA Bit Step Size: 50 mA |

9.5.1.6 REG05_CHARGER_CONTROL 1 Register (Offset = 5h) [reset = 2h]

REG05_CHARGER_CONTRL 1 is shown in 表 9-14.

Return to the Summary Table.

CHARGER_CONTROL 1

English Data Sheet: SLUSE08



表 9-14. REG05_CHARGER_CONTROL 1 Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|----------------|------|-------|----------------------|--|
| 7 | BUSUCP_DIS | R/W | 0h | Reset by: REG_RST | Disable BUSUCP Type: R/W POR: 0b 0h = Enable, BUSUCP turns off Q _B and switching FETs, BUSUCP_STAT and FLAG is set to '1', and INT is sent to host. 1h = Disable, BUSUCP does not turn off Q _B or switching FETs, but BUSUCP_STAT and FLAG is set to '1', and INT is sent to host. |
| 6 | BUSUCP | R/W | Oh | Reset by: REG_RST | BUSUCP Setting. If input current is below BUSUCP threshold after soft start timer expires, the Q_B and switching FETs are turned off and CHG_EN is set to '0' and $\overline{\text{INT}}$ is sent if BUSUCP_DIS=0. If BUSUCP_DIS=1, $\overline{\text{INT}}$ is sent to host but converter keeps running. Change this bit to '1' before CHG_EN is set to '1' in order for BUSUCP to be effective. Type: R/W POR: 0b 0h = RESERVED 1h = 250 mA |
| 5 | BUSRCP_DIS | R/W | Oh | Reset by: REG_RST | Disable BUSRCP Type: R/W POR: 0b 0h = Enable 1h = Disable |
| 4 | BUSRCP | R/W | Oh | Reset by: REG_RST | BUSRCP Setting, if IBUS is below BUSRCP threshold, the Q_B and switching FETs are turned off and CHG_EN is set to '0' and \overline{INT} is sent. Keep this bit set to '0' in order for BUSRCP to be effective. Type: R/W POR: 0b 0h = 300 mA 1h = RESERVED |
| 3 | CHG_CONFIG_1 | R/W | Oh | Reset by: REG_RST | Charger Configuration 1. Set this bit to '1' before CHG_EN is set to '1'. Type: R/W POR: 0h |
| 2 | VBUS_ERRHI_DIS | R/W | Oh | Reset by: REG_RST | Disable VBUS_ERRHI Type: R/W POR: 0b 0h = Enable, converter does not switching, but Q _B is turned on when device is in VBUS_ERRHI 1h = Disable, both converter and Q _B is turned on when device is in VBUS_ERRHI |
| 1-0 | RESERVED | R/W | 2h | Reset by: REG_RST | RESERVED Type: R/W POR: 10b |

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9.5.1.7 REG06_BUSOVP Register (Offset = 6h) [reset = 26h]

REG06_BUSOVP is shown in 表 9-15.

Return to the Summary Table.

BUSOVP



表 9-15. REG06_BUSOVP Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|------------|------|-------|----------------------|---|
| 7 | BUS_PD_EN | R/W | 0h | Reset by: REG_RST | VBUS Pulldown Resistor Control Type: R/W POR: 0b 0h = Disable 1h = Enable |
| 6-0 | BUSOVP_6:0 | R/W | 26h | Reset by: REG_RST | Bus Overvoltage Setting. When the bus voltage reaches the programmed threshold, Q _B and switching FETs are turned off and CHG_EN is set to '0'. The host controller should monitor the bus voltage to ensure that the adapter keeps the voltage under the BUSOVP threshold for proper operation. Switched cap mode: Type: R/W POR: 8900 mV (26h) Range: 7000 mV - 12750 mV Fixed Offset: 7000 mV Bit Step Size: 50 mV Bypass Mode: Type: R/W POR: 4450 mV (26h) Range: 3500 mV - 6500 mV Fixed Offset: 3500 mV Bit Step Size: 25 mV |

9.5.1.8 REG07_BUSOVP_ALM Register (Offset = 7h) [reset = 22h]

REG07_BUSOVP_ALM is shown in 表 9-16.

Return to the Summary Table.

BUSOVP_ALM

表 9-16. REG07 BUSOVP ALM Register Field Descriptions

| | 32 3-1 | 0. IXE 007 | | gister Fleid Descriptions | |
|-----|----------------|------------|-------|---------------------------|--|
| Bit | Field | Туре | Reset | Note | Description |
| 7 | BUSOVP_ALM_DIS | R/W | Oh | Reset by: REG_RST | Disable BUSOVP_ALM Type: R/W POR: 0b 0h = Enable 1h = Disable |
| 6-0 | BUSOVP_ALM_6:0 | R/W | 22h | Reset by: REG_RST | Bus Overvoltage Alarm Setting. When the bus voltage reaches the programmed threshold, an INT is sent. The host controller should monitor the bus voltage to ensure that the adapter keeps the voltage under the BUSOVP threshold for proper operation. Switched Cap Mode: Type: R/W POR: 8700 mV (22h) Range: 7000 mV - 13350 mV Fixed Offset: 7000 mV Bit Step Size: 50 mV Bypass Mode: Type: R/W POR: 4350 mV (22h) Range: 3500 mV - 6675 mV Fixed Offset: 3500 mV Bit Step Size: 25 mV |

9.5.1.9 REG08_BUSOCP Register (Offset = 8h) [reset = Bh]

REG08_BUSOCP is shown in 表 9-17.

English Data Sheet: SLUSE08



Return to the Summary Table.

BUSOCP

表 9-17. REG08_BUSOCP Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|------------|------|-------|----------------------|--|
| 7-5 | RESERVED | R | 0h | | RESERVED |
| 4-0 | BUSOCP_4:0 | R/W | Bh | Reset by: REG_RST | BUS Overcurrent Protection Setting. When the bus current reaches the programmed threshold, the output is disabled. The host controller should monitor the bus current to ensure that the adapter keeps the current under this threshold for proper operation. Type: R/W Switched Cap Mode: POR: 3816 mA (Bh) Range: 1017.5 mA - 4579 mA Fixed Offset: 1017.5 mA Bit Step Size: 254 mA Bypass Mode: POR: 3928 mA (Bh) Range: 1047.5 mA - 6809 mA Fixed Offset: 1047.5 mA Bit Step Size: 262 mA |

9.5.1.10 REG09_BUSOCP_ALM Register (Offset = 9h) [reset = Ch]

REG09_BUSOCP_ALM is shown in 表 9-18.

Return to the Summary Table.

BUSOCP_ALM

表 9-18. REG09 BUSOCP ALM Register Field Descriptions

| | # 3-10. RE003_B00001 _AEM Register Field Bescriptions | | | | | | | | |
|-----|---|------|-------|----------------------|--|--|--|--|--|
| Bit | Field | Туре | Reset | Note | Description | | | | |
| 7 | BUSOCP_ALM_DIS | R/W | Oh | Reset by: REG_RST | Disable BUSOCP_ALM Type: R/W POR: 0b 0h = Enable 1h = Disable | | | | |
| 6-5 | RESERVED | R | 0h | | RESERVED | | | | |
| 4-0 | BUSOCP_ALM_4:0 | R/W | Ah | Reset by: REG_RST | Bus Overvoltage Alarm Setting. When the bus current reaches the programmed threshold, an INT is sent. The host controller should monitor the bus current to ensure that the adapter keeps the current under the BUSOCP threshold for proper operation. Type: R/W POR: 3500 mA (Ah) Range: 1000 mA - 8750 mA Fixed Offset: 1000 mA Bit Step Size: 250 mA | | | | |

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9.5.1.11 REG0A_TEMP_CONTROL Register (Offset = Ah) [reset = 60h]

REG0A_TEMP_CONTROL is shown in 表 9-19.

Return to the Summary Table.

TEMP_CONTROL

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表 9-19. REG0A_TEMP_CONTROL Register Field Descriptions

| 2X 3-13. NEGUA_ | | | <u> </u> | THE TOP I | register Fleid Descriptions |
|-----------------|---------------|------|----------|----------------------|---|
| Bit | Field | Туре | Reset | Note | Description |
| 7 | TDIE_FLT_DIS | R/W | Oh | Reset by: REG_RST | Disable TDIE Overtemperature Protection Type: R/W POR: 0b 0h = TDIE_FLT enable 1h = TDIE_FLT disable |
| 6-5 | TDIE_FLT_1:0 | R/W | 3h | Reset by: REG_RST | TDIE Overtemperature Setting. When the junction temperature reaches the programmed threshold, the Q_B and switching FETs are turned off and CHG_EN is set to '0'. Type: R/W POR: 11b 0h = 80C 1h = 100C 2h = 120C 3h = 140C |
| 4 | TDIE_ALM_DIS | R/W | 0h | Reset by: REG_RST | Disable TDIE Overtemperature Alarm Type : R/W POR: 0b 0h = TDIE_ALM enable 1h = TDIE_ALM disable |
| 3 | TSBUS_FLT_DIS | R/W | Oh | Reset by: REG_RST | Disable TSBUS_FLT Type : R/W POR: 0b 0h = TSBUS_FLT enable 1h = TSBUS_FLT disable |
| 2 | TSBAT_FLT_DIS | R/W | Oh | Reset by: REG_RST | Disable TSBAT_FLT Type : R/W POR: 0b 0h = TSBAT_FLT enable 1h = TSBAT_FLT disable |
| 1-0 | RESERVED | R | 0h | | RESERVED Type:R POR:00b |

9.5.1.12 REG0B_TDIE_ALM Register (Offset = Bh) [reset = C8h]

REG0B_TDIE_ALM is shown in 表 9-20.

Return to the Summary Table.

TDIE_ALM

表 9-20. REG0B_TDIE_ALM Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|--------------|------|-------|----------------------|--|
| 7-0 | TDIE_ALM_7:0 | R/W | | Reset by: REG_RST | Die Overtemperature Alarm Setting. When the junction temperature reaches the programmed threshold, an $\overline{\text{INT}}$ is sent. Type: R/W POR: 125°C (C8h) Range: 25°C - 150°C Fixed Offset: 25°C Bit Step Size: 0.5°C |

9.5.1.13 REG0C_TSBUS_FLT Register (Offset = Ch) [reset = 15h]

REG0C_TSBUS_FLT is shown in 表 9-21.



Return to the Summary Table.

TSBUS_FLT

表 9-21. REG0C_TSBUS_FLT Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|---------------|------|-------|----------------------|---|
| 7-0 | TSBUS_FLT_7:0 | R/W | 15h | Reset by: REG_RST | TSBUS Percentage Fault Threshold. When the TSBUS/REGN ratio drops below the programmed threshold, the Q_B and switching FETs are turned off and CHG_EN is set to '0'. Type: R/W POR: 4.10151% (15h) Range: 0% - 49.8041% Fixed Offset: 0% Bit Step Size: 0.19531% |

9.5.1.14 REG0D_TSBAT_FLT Register (Offset = Dh) [reset = 15h]

REG0D_TSBAT_FLG is shown in 表 9-22.

Return to the Summary Table.

TSBAT_FLG

表 9-22. REG0D_TSBAT_FLT Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|---------------|------|-------|------|---|
| 7-0 | TSBAT_FLT_7:0 | R/W | | _ | TSBAT Percentage Fault Threshold. When the TSBAT/REGN ratio drops below the programmed threshold, the Q_B and switching FETs are turned off and CHG_EN is set to '0'. Type: R/W POR: 4.10151% (15h) Range: 0% - 49.8041% Fixed Offset: 0% Bit Step Size: 0.19531% |

9.5.1.15 REG0E_VAC_CONTROL Register (Offset = Eh) [reset = 0h]

REG0E_VAC_CONTROL is shown in 表 9-23.

Return to the Summary Table.

VAC_CONTROL

表 9-23. REG0E_VAC_CONTROL Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|-------------|------|-------|----------------------|--|
| 7-5 | VAC1OVP_2:0 | R/W | Oh | Reset by: REG_RST | VAC10VP Setting. When VAC1 voltage reaches the programmed threshold, ACDRV1 is turned off. Type: R/W POR: 000b 0h = 6.5 V 1h = 10.5 V 2h = 12 V 3h = 14 V 4h = 16 V 5h = 18 V |

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表 9-23. REG0E_VAC_CONTROL Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Note | Description |
|-----|-------------|------|-------|----------------------|---|
| 4-2 | VAC2OVP_2:0 | R/W | Oh | Reset by: REG_RST | VAC2OVP Setting. When VAC2 voltage reaches the programmed threshold, ACDRV2 is turned off. Type: R/W POR: 000b 0h = 6.5 V 1h = 10.5 V 2h = 12 V 3h = 14 V 4h = 16 V 5h = 18 V |
| 1 | VAC1_PD_EN | R/W | Oh | Reset by: REG_RST | Enable VAC1 Pulldown Resistor Type: R/W POR: 0b 0h = Disable 1h = Enable |
| 0 | VAC2_PD_EN | R/W | Oh | Reset by: REG_RST | Enable VAC2 Pulldown Resistor Type: R/W POR: 0b 0h = Disable 1h = Enable |

9.5.1.16 REG0F_CHARGER_CONTROL 2 Register (Offset = Fh) [reset = 0h]

REG0F_CHARGER_CONTROL 2 is shown in 表 9-24.

Return to the Summary Table.

CHARGER CONTROL 2

表 9-24. REG0F_CHARGER_CONTROL 2 Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description Description |
|-----|---------|------|-------|----------------------------------|---|
| - | | | | | - |
| 7 | REG_RST | R/W | 0h | Reset by: REG_RST | Register Reset. Reset registers to default values and reset timer. This bit automatically goes back to '0' after reset. Type: R/W POR: 0b 0h = Not reset register 1h = Reset register |
| 6 | EN_HIZ | R/W | 0h | Reset by: REG_RST | Enable HIZ Mode. When device is in HIZ mode, converter stops switching, ADC stops converting, ACDRV is turned off and the REGN LDO is forced off. Type: R/W POR: 0b 0h = Disable HIZ mode 1h = Enable HIZ mode |
| 5 | EN_OTG | R/W | 0h | Reset by: WATCHDOG REG_RST | Power Path Control During the OTG and Reverse TX Mode Type: R/W POR: 0b 0h = Don't allow host to control ACDRV(s) 1h = Allow host to control ACDRV(s) |
| 4 | CHG_EN | R/W | 0h | Reset by: WATCHDOG REG_RST | Charge Enable Type: R/W POR: 0b 0h = Disable charge 1h = Enable charge |

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表 9-24. REG0F_CHARGER_CONTROL 2 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Note | Description |
|-----|----------------|------|-------|----------------------------------|---|
| 3 | EN_BYPASS | R/W | Oh | Reset by: WATCHDOG REG_RST | Enable Bypass Mode Type: R/W POR: 0b 0h = Disable Bypass Mode 1h = Enable Bypass Mode |
| 2 | DIS_ACDRV_BOTH | R/W | Oh | | Disable Both ACDRV. When this bit is set, the device forces both ACDRV off. It is not reset by the REG_RST or the WATCHDOG. Type: R/W POR: 0b 0h = ACDRV1 and ACDRV2 can be turned on 1h = ACDRV1 and ACDRV2 are forced off |
| 1 | ACDRV1_STAT | R/W | Oh | | External ACFET1-RBFET1 Gate Driver Status. For dual input with two sets ACFET-RBFET, this bit can be used to swap input. It is not reset by the REG_RST or the WATCHDOG. Type: R/W POR: 0b 0h = ACDRV1 is OFF 1h = ACDRV1 is ON |
| 0 | ACDRV2_STAT | R/W | Oh | | External ACFET2-RBFET2 Gate Driver Status. For dual input with two sets ACFET-RBFET, this bit can be used to swap input. It is not reset by the REG_RST or the WATCHDOG. Type: R/W POR: 0b 0h = ACDRV2 is OFF 1h = ACDRV2 is ON |

9.5.1.17 REG10_CHARGER_CONTROL 3 Register (Offset = 10h) [reset = 83h]

REG10_CHARGER_CONTROL 3 is shown in 表 9-25.

Return to the Summary Table.

CHARGER CONTROL 3

表 9-25. REG10_CHARGER_CONTROL 3 Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|--------------|------|-------|----------------------|---|
| 7-5 | FSW_SET_2:0 | R/W | 4h | | Set Switching Frequency in Switched Cap Mode. It is not reset by the REG_RST or the WATCHDOG. Type: R/W POR: 100b 0h = 187.5 kHz 1h = 250 kHz 2h = 300 kHz 3h = 375 kHz 4h = 500 kHz 5h = 750 kHz The maximum switching frequency is 500 kHz in dual charger configuration. |
| 4-3 | WATCHDOG_1:0 | R/W | Oh | Reset by: REG_RST | Watchdog Timer Type: R/W POR: 00b 0h = 0.5 s 1h = 1 s 2h = 5 s 3h = 30 s |



表 9-25. REG10_CHARGER_CONTROL 3 Register Field Descriptions (continued)

| | - ' | • | _ | U | • |
|-----|--------------|------|-------|---------|---|
| Bit | Field | Туре | Reset | Note | Description |
| 2 | WATCHDOG_DIS | R/W | Oh | REG_RST | Watchdog Timer Control Type: R/W POR: 0b 0h = Enable 1h = Disable |
| 1-0 | RESERVED | R | 3h | | RESERVED |

9.5.1.18 REG11_CHARGER_CONTROL 4 Register (Offset = 11h) [reset = 71h]

REG11_CHARGER_CONTROL 4 is shown in 表 9-26.

Return to the Summary Table.

CHARGER CONTROL 4

表 9-26. REG11_CHARGER_CONTROL 4 Register Field Descriptions

| | 表 9-26. REG11_CHARGER_CONTROL 4 Register Field Descriptions | | | | | | | | |
|-----|---|------|-------|----------------------|--|--|--|--|--|
| Bit | Field | Туре | Reset | Note | Description | | | | |
| 7 | RSNS | R/W | Oh | Reset by: REG_RST | Battery Current Sense Resistor Value Type : R/W POR: 0b $0h = 2 \ m\Omega$ $1h = 5 \ m\Omega$ | | | | |
| 6-4 | SS_TIMEOUT_2:0 | R/W | 7h | | Soft Start Timeout to Check if Input Current is Above BUSUCP Threshold. It is not reset by the REG_RST or the WATCHDOG. Type: R/W POR: 111b 0h = 6.25 ms 1h = 12.5 ms 2h = 25 ms 3h = 50 ms 4h = 100 ms 5h = 400 ms 6h = 1.5 s 7h = 10 s | | | | |
| 3-2 | IBUSUCP_FALL_DG_SEL_1:0 | R/W | Oh | Reset by: REG_RST | BUSUCP Deglitch Timer Type: R/W POR: 00b 0h = 0.01 ms 1h = 5 ms 2h = 50 ms 3h = 150 ms | | | | |
| 1-0 | RESERVED | R/W | 1h | Reset by: REG_RST | RESERVED Type: R/W POR: 1b | | | | |

9.5.1.19 REG12_CHARGER_CONTROL 5 Register (Offset = 12h) [reset = 60h]

REG12_CHARGER_CONTROL 5 is shown in 表 9-27.

Return to the Summary Table.

CHARGER CONTROL 5



表 9-27. REG12_CHARGER_CONTROL 5 Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|----------------|------|-------|----------------------|---|
| 7 | VOUTOVP_DIS | R/W | 0h | Reset by: REG_RST | Disable VOUTOVP Type: R/W POR: 0b 0h = Enable 1h = Disable |
| 6-5 | VOUTOVP_1:0 | R/W | 3h | Reset by: REG_RST | VOUTOVP Protection. When output voltage is above the programmed threshold, Q_B and switching FETs are turned off and CHG_EN is set to '0'. Type: R/W POR: 11b 0h = 4.7 V 1h = 4.8 V 2h = 4.9 V 3h = 5.0 V |
| 4-3 | FREQ_SHIFT_1:0 | R/W | 0h | Reset by: REG_RST | Adjust Switching Frequency Type: R/W POR: 00b 0h = Nominal switching frequency set in REG10[7:5] 1h = Set switching frequency 10% higher than normal 2h = Set switching frequency 10% lower than normal |
| 2 | RESERVED | R/W | Oh | Reset by: REG_RST | RESERVED Type: R/W POR: 0b |
| 1-0 | MS_1:0 | R | Oh | | Primary, Secondary, Standalone Operation Type: R POR: 00b 0h = Standalone 1h = Secondary 2h = Primary |

9.5.1.20 REG13_STAT 1 Register (Offset = 13h) [reset = 0h]

REG13_STAT 1 is shown in 表 9-28.

Return to the Summary Table.

STAT 1

表 9-28. REG13_STAT 1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|-----------------|------|-------|--|
| 7 | BATOVP_STAT | R | 0h | BATOVP Status Type: R POR: 0b 0h = Not in BATOVP 1h = In BATOVP |
| 6 | BATOVP_ALM_STAT | R | 0h | BATOVP_ALM Status Type : R POR: 0b 0h = Not in BATOVP_ALM 1h = In BATOVP_ALM |
| 5 | VOUTOVP_STAT | R | 0h | VOUTOVP Status Type: R POR: 0b 0h = Not in VOUTOVP 1h = in VOUTOVP |

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表 9-28. REG13_STAT 1 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|-----------------|------|-------|---|
| 4 | BATOCP_STAT | R | Oh | BATOCP Status Type: R POR: 0b 0h = Not in BATOCP 1h = In BATOCP |
| 3 | BATOCP_ALM_STAT | R | Oh | BATOCP_ALM Status Type: R POR: 0b 0h = Not in BATOCP_ALM 1h = In BATOCP_ALM |
| 2 | BATUCP_ALM_STAT | R | Oh | BATUCP_ALM Status Type: R POR: 0b 0h = Not in BATUCP_ALM 1h = In BATUCP_ALM |
| 1 | BUSOVP_STAT | R | 0h | VBUSOVP Status Type: R POR: 0b 0h = Not in VBUS OVP 1h = In VBUS OVP |
| 0 | BUSOVP_ALM_STAT | R | 0h | BUSOVP_ALM Status Type: R POR: 0b 0h = Not in BUSOVP_ALM 1h = In BUSOVP_ALM |

9.5.1.21 REG14_STAT 2 Register (Offset = 14h) [reset = 0h]

REG14_STAT 2 is shown in 表 9-29.

Return to the Summary Table.

STAT 2

表 9-29. REG14 STAT 2 Register Field Descriptions

| | 及 3-23. REG14_STAT 2 Register Field Descriptions | | | | | | | |
|-----|--|------|-------|---|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | |
| 7 | BUSOCP_STAT | R | 0h | BUSOCP Status Type: R POR: 0b 0h = Not in BUSOCP 1h = In BUSOCP | | | | |
| 6 | BUSOCP_ALM_STAT | R | 0h | BUSOCP_ALM Status Type: R POR: 0b 0h = Not in BUSOCP_ALM 1h = In BUSOCP_ALM | | | | |
| 5 | BUSUCP_STAT | R | 0h | BUSUCP Status Type: R POR: 0b 0h = Not in BUSUCP 1h = In BUSUCP | | | | |



表 9-29. REG14_STAT 2 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|-----------------|------|-------|--|
| 4 | BUSRCP_STAT | R | 0h | BUSRCP Status Type: R POR: 0b 0h = Not in BUSRCP 1h = In BUSRCP |
| 3 | RESERVED | R | 0h | RESERVED |
| 2 | CFLY_SHORT_STAT | R | 0h | CFLY Short Detection Status Type : R POR: 0b 0h = CFLY not shorted 1h = CFLY shorted |
| 1-0 | RESERVED | R | 0h | RESERVED |

9.5.1.22 REG15_STAT 3 Register (Offset = 15h) [reset = 0h]

REG15_STAT 3 is shown in 表 9-30.

Return to the Summary Table.

STAT 3

表 9-30. REG15_STAT 3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|------------------|------|-------|--|
| 7 | VAC10VP_STAT | R | 0h | VAC1 OVP Status Type: R POR: 0b 0h = Not in VAC1 OVP 1h = In VAC1 OVP |
| 6 | VAC2OVP_STAT | R | 0h | VAC2 OVP Status Type : R POR: 0b 0h = Not in VAC2 OVP 1h = In VAC2 OVP |
| 5 | VOUTPRESENT_STAT | R | 0h | VOUT Present Status Type : R POR: 0b 0h = VOUT not present 1h = VOUT present |
| 4 | VAC1PRESENT_STAT | R | 0h | VAC1 Present Status Type: R POR: 0b 0h = VAC1 not present 1h = VAC1 present |
| 3 | VAC2PRESENT_STAT | R | 0h | VAC2 Present Status Type: R POR: 0b 0h = VAC2 not present 1h = VAC2 present |
| 2 | VBUSPRESENT_STAT | R | 0h | VBUS Present Status Type : R POR: 0b 0h = VBUS not present 1h = VBUS present |

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表 9-30. REG15_STAT 3 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|-------------------|------|-------|---|
| 1 | ACRB1_CONFIG_STAT | R | 0h | ACFET1-RBFET1 Status Type : R POR: 0b 0h = ACFET1-RBFET1 is not placed 1h = ACFET1-RBFET1 is placed |
| 0 | ACRB2_CONFIG_STAT | R | 0h | ACFET2-RBFET2 Status Type : R POR: 0b 0h = ACFET2-RBFET2 is not placed 1h = ACFET2-RBFET2 is placed |

9.5.1.23 REG16_STAT 4 Register (Offset = 16h) [reset = 0h]

REG16_STAT 4 is shown in 表 9-31.

Return to the Summary Table.

STAT 4

表 9-31. REG16_STAT 4 Register Field Descriptions

| | 表 9-31. REG16_STAL 4 Register Field Descriptions | | | | | | | | |
|-----|--|------|-------|--|--|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | | |
| 7 | ADC_DONE_STAT | R | Oh | ADC Conversion Status (in One-Shot Mode only) Note: Always reads 0 in continuous mode Type: R POR: 0b 0h = Conversion not complete 1h = Conversion complete | | | | | |
| 6 | SS_TIMEOUT_STAT | R | 0h | Soft-Start Timeout Status Type: R POR: 0b 0h = Device not in soft timeout 1h = Device in soft timeout | | | | | |
| 5 | TSBUS_TSBAT_ALM_STAT | R | 0h | TSBUS and TSBAT ALM Status Type: R POR: 0b 0h = TSBUS or TSBAT threshold is NOT within 5% of the TSBUS_FLT or TSBAT_FLT set threshold 1h = TSBUS or TSBAT threshold is within 5% of the TSBUS_FLT or TSBAT_FLT set threshold | | | | | |
| 4 | TSBUS_FLT_STAT | R | 0h | TSBUS_FLT Status Type: R POR: 0b 0h = Not in TSBUS_FLT 1h = In TSBUS_FLT | | | | | |
| 3 | TSBAT_FLT_STAT | R | 0h | TSBAT_FLT Status Type : R POR: 0b 0h = Not in TSBAT_FLT 1h = In TSBAT_FLT | | | | | |
| 2 | TDIE_FLT_STAT | R | 0h | TDIE Fault Status Type: R POR: 0b 0h = Not in TDIE fault 1h = In TDIE fault | | | | | |



表 9-31. REG16_STAT 4 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|---------------|------|-------|--|
| 1 | TDIE_ALM_STAT | R | 0h | TDIE_ALM Status Type : R POR: 0b 0h = Not in TDIE_ALM 1h = In TDIE_ALM |
| 0 | WD_STAT | R | 0h | I ² C Watch Dog Status Type : R POR: 0b 0h = Normal 1h = WD timer expired |

9.5.1.24 REG17_STAT 5 Register (Offset = 17h) [reset = 0h]

REG17_STAT 5 is shown in 表 9-32.

Return to the Summary Table.

STAT 5

表 9-32. REG17_STAT 5 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|------------------|------|-------|--|
| 7 | REGN_GOOD_STAT | R | Oh | REGN_GOOD Status Type : R POR: 0b 0h = REGN not good 1h = REGN good |
| 6 | CONV_ACTIVE_STAT | R | Oh | Converter Active Status Type : R POR: 0b 0h = Converter not running 1h = Converter running |
| 5 | RESERVED | R | 0h | RESERVED |
| 4 | VBUS_ERRHI_STAT | R | 0h | VBUS_ERRHI Status Type: R POR: 0b 0h = Not in VBUS_ERRHI status 1h = In VBUS_ERRHI status |
| 3-0 | RESERVED | R | 0h | RESERVED |

9.5.1.25 REG18_FLAG 1 Register (Offset = 18h) [reset = 0h]

REG18_FLAG 1 is shown in 表 9-33.

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FLAG 1

表 9-33. REG18_FLAG 1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|-------------|------|-------|--|
| 7 | BATOVP_FLAG | R | Oh | BATOVP Flag Type: R POR: 0b 0h = Normal 1h = BATOVP status changed |
| | | | | III = BATOVP status changed |



表 9-33. REG18_FLAG 1 Register Field Descriptions (continued)

| 表 9-33. REG18_FLAG 1 Register Field Descriptions (continued) | | | | | | | |
|--|-----------------|------|-------|---|--|--|--|
| Bit | Field | Туре | Reset | Description | | | |
| 6 | BATOVP_ALM_FLAG | R | Oh | BATOVP_ALM Flag Type : R POR: 0b 0h = Normal 1h = BATOVP_ALM status changed | | | |
| 5 | VOUTOVP_FLAG | R | Oh | VOUTOVP Flag Type : R POR: 0b 0h = Normal 1h = VOUTOVP status changed | | | |
| 4 | BATOCP_FLAG | R | 0h | BATOCP Flag Type : R POR: 0b 0h = Normal 1h = BATOCP status changed | | | |
| 3 | BATOCP_ALM_FLAG | R | Oh | BATOCP_ALM Flag Type : R POR: 0b 0h = Normal 1h = BATOCP_ALM status changed | | | |
| 2 | BATUCP_ALM_FLAG | R | 0h | BATUCP_ALM Flag Type : R POR: 0b 0h = Normal 1h = BATUCP_ALM status changed | | | |
| 1 | BUSOVP_FLAG | R | 0h | BUSOVP Flag Type: R POR: 0b 0h = Normal 1h = BUSOVP status changed | | | |
| 0 | BUSOVP_ALM_FLAG | R | Oh | BUSOVP_ALM Flag Type : R POR: 0b 0h = Normal 1h = BUSOVP_ALM status changed | | | |

9.5.1.26 REG19_FLAG 2 Register (Offset = 19h) [reset = 0h]

REG19_FLAG 2 is shown in 表 9-34.

Return to the Summary Table.

FLAG 2

表 9-34. REG19_FLAG 2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|-------------|------|-------|----------------------------|
| 7 | BUSOCP_FLAG | R | 0h | BUSOCP Flag |
| | | | | Type : R |
| | | | | POR: 0b |
| | | | | 0h = Normal |
| | | | | 1h = BUSOCP status changed |
| | | I | I | |



表 9-34. REG19_FLAG 2 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|-----------------|------|-------|--------------------------------|
| | | | | |
| 6 | BUSOCP_ALM_FLAG | R | 0h | BUSOCP_ALM Flag |
| | | | | Type : R POR: 0b |
| | | | | 0h = Normal |
| | | | | |
| | | | | 1h = BUSOCP_ALM status changed |
| 5 | BUSUCP_FLAG | R | 0h | BUSUCP Flag |
| | | | | Type: R |
| | | | | POR: 0b |
| | | | | 0h = Normal |
| | | | | 1h = BUSUCP status changed |
| 4 | BUSRCP FLAG | R | 0h | BUSRCP Flag |
| | _ | | | Type : R |
| | | | | POR: 0b |
| | | | | 0h = Normal |
| | | | | 1h = BUSRCP status changed |
| 3 | RESERVED | R | 0h | RESERVED |
| 2 | CFLY_SHORT_FLAG | R | 0h | CFLY Short Flag |
| | | | | Type : R |
| | | | | POR: 0b |
| | | | | 0h = Normal |
| | | | | 1h = CFLY_SHORT status changed |
| 1-0 | RESERVED | R | 0h | RESERVED |

9.5.1.27 REG1A_FLAG 3 Register (Offset = 1Ah) [reset = 0h]

REG1A_FLAG 3 is shown in 表 9-35.

Return to the Summary Table.

FLAG 3

表 9-35. REG1A_FLAG 3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|------------------|------|-------|---|
| 7 | VAC10VP_FLAG | R | Oh | VAC10VP Flag Type : R POR: 0b 0h = Normal 1h = VAC1 OVP status changed |
| 6 | VAC2OVP_FLAG | R | Oh | VAC2OVP Flag Type : R POR: 0b 0h = Normal 1h = VAC2 OVP status changed |
| 5 | VOUTPRESENT_FLAG | R | Oh | VOUT Present Flag Type : R POR: 0b 0h = Normal 1h = VOUT present status changed |
| 4 | VAC1PRESENT_FLAG | R | Oh | VAC1 Present Flag Type : R POR: 0b 0h = Normal 1h = VAC1 present status changed |

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表 9-35. REG1A_FLAG 3 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|-------------------|------|-------|---|
| 3 | VAC2PRESENT_FLAG | R | Oh | VAC2 Present Flag Type : R POR: 0b 0h = Normal 1h = VAC2 present status changed |
| 2 | VBUSPRESENT_FLAG | R | Oh | VBUS Present Flag Type : R POR: 0b 0h = Normal 1h = VBUS present status changed |
| 1 | ACRB1_CONFIG_FLAG | R | Oh | ACFET1-RBFET1_CONFIG Flag Type : R POR: 0b 0h = Normal 1h = ACFET1-RBFET1_CONFIG status changed |
| 0 | ACRB2_CONFIG_FLAG | R | Oh | ACFET2-RBFET2_CONFIG Flag Type : R POR: 0b 0h = Normal 1h = ACFET2-RBFET2_CONFIG status changed |

9.5.1.28 REG1B_FLAG 4 Register (Offset = 1Bh) [reset = 0h]

REG1B_FLAG 4 is shown in 表 9-36.

Return to the Summary Table.

FLAG 4

表 9-36. REG1B_FLAG 4 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|----------------------|------|-------|---|
| 7 | ADC_DONE_FLAG | R | Oh | ADC Conversion Flag (in One-Shot Mode only) Type: R POR: 0b 0h = Normal 1h = ADC conversion done status changed |
| 6 | SS_TIMEOUT_FLAG | R | Oh | Soft-Start Timeout Flag Type: R POR: 0b 0h = Normal 1h = Soft start timeout status changed |
| 5 | TSBUS_TSBAT_ALM_FLAG | R | Oh | TSBUS_TSBAT_ALM Flag Type: R POR: 0b 0h = Normal 1h = Converter active status changed |
| 4 | TSBUS_FLT_FLAG | R | Oh | TSBUS_FLT Flag Type: R POR: 0b 0h = Normal 1h = TSBUS_FLT status changed |



表 9-36. REG1B_FLAG 4 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|----------------|------|-------|---|
| 3 | TSBAT_FLT_FLAG | R | 0h | TSBAT_FLT Flag Type : R POR: 0b 0h = Normal 1h = TSBAT_FLT status changed |
| 2 | TDIE_FLT_FLAG | R | 0h | TDIE_FLT Flag Type : R POR: 0b 0h = Normal 1h = TDIE_FLT status changed |
| 1 | TDIE_ALM_FLAG | R | 0h | TDIE_ALM Flag Type : R POR: 0b 0h = Normal 1h = TDIE_ALM status changed |
| 0 | WD_FLAG | R | 0h | I ² C Watch Dog Timer Flag Type : R POR: 0b 0h = Normal 1h = WD timer status changed |

9.5.1.29 REG1C_FLAG 5 Register (Offset = 1Ch) [reset = 0h]

REG1C_FLAG 5 is shown in 表 9-37.

Return to the Summary Table.

FLAG 5

表 9-37. REG1C FLAG 5 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|------------------|------|-------|---|
| 7 | REGN_GOOD_FLAG | R | Oh | REGN_GOOD Flag Type : R POR: 0b 0h = Normal 1h = REGN_GOOD status changed |
| 6 | CONV_ACTIVE_FLAG | R | 0h | Converter Active Flag Type : R POR: 0b 0h = Normal 1h = Converter active status changed |
| 5 | RESERVED | R | 0h | RESERVED |
| 4 | VBUS_ERRHI_FLAG | R | 0h | VBUS_ERRHI Flag Type : R POR: 0b 0h = Normal 1h = VBUS_ERRHI status changed |
| 3-0 | RESERVED | R | 0h | RESERVED |

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9.5.1.30 REG1D_MASK 1 Register (Offset = 1Dh) [reset = 0h]

REG1D_MASK 1 is shown in 表 9-38.

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MASK 1

表 9-38. REG1D_MASK 1 Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|-----------------|------|-------|----------------------|--|
| 7 | BATOVP_MASK | R/W | Oh | Reset by: REG_RST | BATOVP Mask Type: R/W POR: 0b 0h = BATOVP flag produce INT 1h = BATOVP flag does not produce INT |
| 6 | BATOVP_ALM_MASK | R/W | Oh | Reset by: REG_RST | BATOVP_ALM Mask Type: R/W POR: 0b 0h = BATOVP_ALM flag produce ĪNT 1h = BATOVP_ALM flag does not produce ĪNT |
| 5 | VOUTOVP_MASK | R/W | 0h | Reset by: REG_RST | VOUTOVP Mask Type: R/W POR: 0b 0h = VOUTOVP flag produce INT 1h = VOUTOVP flag does not produce INT |
| 4 | BATOCP_MASK | R/W | Oh | Reset by: REG_RST | BATOCP Mask Type: R/W POR: 0b 0h = BATOCP flag produce INT 1h = BATOCP flag does not produce INT |
| 3 | BATOCP_ALM_MASK | R/W | 0h | Reset by: REG_RST | BATOCP_ALM Mask Type: R/W POR: 0b 0h = BATOCP_ALM flag produce INT 1h = BATOCP_ALM flag does not produce INT |
| 2 | BATUCP_ALM_MASK | R/W | Oh | Reset by: REG_RST | BATUCP_ALM Mask Type: R/W POR: 0b 0h = BATUCP_ALM flag produce INT 1h = BATUCP_ALM flag does not produce INT |
| 1 | BUSOVP_MASK | R/W | Oh | Reset by: REG_RST | BUSOVP Mask Type: R/W POR: 0b 0h = BUSOVP flag produce ĪNT 1h = BUSOVP flag does not produce ĪNT |
| 0 | BUSOVP_ALM_MASK | R/W | 0h | Reset by: REG_RST | BUSOVP_ALM Mask Type: R/W POR: 0b 0h = BUSOVP_ALM flag produce INT 1h = BUSOVP_ALM flag does not produce INT |

9.5.1.31 REG1E_MASK 2 Register (Offset = 1Eh) [reset = 0h]

REG1E_MASK 2 is shown in 表 9-39.

Return to the Summary Table.

MASK 2



表 9-39. REG1E_MASK 2 Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|-----------------|------|-------|----------------------|--|
| 7 | BUSOCP_MASK | R/W | 0h | Reset by: REG_RST | BUSOCP Mask Type: R/W POR: 0b 0h = BUSOCP flag produce INT 1h = BUSOCP flag does not produce INT |
| 6 | BUSOCP_ALM_MASK | R/W | Oh | Reset by: REG_RST | BUSOCP_ALM Mask Type: R/W POR: 0b 0h = BUSOCP_ALM flag produce INT 1h = BUSOCP_ALM flag does not produce INT |
| 5 | BUSUCP_MASK | R/W | 0h | Reset by: REG_RST | BUSUCP Mask Type: R/W POR: 0b 0h = BUSUCP flag produce INT 1h = BUSUCP flag does not produce INT |
| 4 | BUSRCP_MASK | R/W | Oh | Reset by: REG_RST | BUSRCP Mask Type: R/W POR: 0b 0h = BUSRCP flag produce ĪNT 1h = BUSRCP flag does not produce ĪNT |
| 3 | RESERVED | R/W | 0h | Reset by: REG_RST | RESERVED |
| 2 | CFLY_SHORT_MASK | R/W | Oh | Reset by: REG_RST | CFLY_SHORT Mask Type: R/W POR: 0b 0h = CFLY_SHORT flag produce ĪNT 1h = CFLY_SHORT flag does not produce ĪNT |
| 1 | RESERVED | R/W | 0h | Reset by: REG_RST | RESERVED Type : R/W POR: 0h |
| 0 | RESERVED | R | 0h | | RESERVED |

9.5.1.32 REG1F_MASK 3 Register (Offset = 1Fh) [reset = 0h]

REG1F_MASK 3 is shown in 表 9-40.

Return to the Summary Table.

MASK 3

表 9-40. REG1F_MASK 3 Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|--------------|------|-------|----------------------|---|
| 7 | VAC1OVP_MASK | R/W | 0h | Reset by: REG_RST | VAC1OVP Mask Type: R/W POR: 0b 0h = VAC1OVP flag produce ĪNT 1h = VAC1OVP flag does not produce ĪNT |
| 6 | VAC2OVP_MASK | R/W | 0h | Reset by: REG_RST | VAC2OVP Mask Type: R/W POR: 0b 0h = VAC2OVP flag produce ĪNT 1h = VAC2OVP flag does not produce ĪNT |



表 9-40. REG1F_MASK 3 Register Field Descriptions (continued)

| Bit | Field | Type | Reset | Note | Description |
|-----|-------------------|------|-------|----------------------|--|
| 5 | VOUTPRESENT_MASK | R/W | 0h | Reset by: REG_RST | VOUTPRESENT Mask Type: R/W POR: 0b 0h = VOUTPRESENT flag produce ĪNT 1h = VOUTPRESENT flag does not produce ĪNT |
| 4 | VAC1PRESENT_MASK | R/W | Oh | Reset by: REG_RST | VAC1PRESENT Mask Type: R/W POR: 0b 0h = VAC1PRESENT flag produce INT 1h = VAC1PRESENT flag does not produce INT |
| 3 | VAC2PRESENT_MASK | R/W | 0h | Reset by: REG_RST | VAC2PRESENT Mask Type: R/W POR: 0b 0h = VAC2PRESENT flag produce INT 1h = VAC2PRESENT flag does not produce INT |
| 2 | VBUSPRESENT_MASK | R/W | Oh | Reset by: REG_RST | VBUSPRESENT Mask Type: R/W POR: 0b 0h = VBUSPRESENT flag produce INT 1h = VBUSPRESENT flag does not produce INT |
| 1 | ACRB1_CONFIG_MASK | R/W | 0h | Reset by: REG_RST | ACFET1-RBFET1 CONFIG Mask Type: R/W POR: 0b 0h = ACRB1_CONFIG flag produce INT 1h = ACRB1_CONFIG flag does not produce INT |
| 0 | ACRB2_CONFIG_MASK | R/W | 0h | Reset by: REG_RST | ACFET2-RBFET2 CONFIG Mask Type: R/W POR: 0b 0h = ACRB2_CONFIG flag produce INT 1h = ACRB2_CONFIG flag does not produce INT |

9.5.1.33 REG20_MASK 4 Register (Offset = 20h) [reset = 0h]

REG20_MASK 4 is shown in 表 9-41.

Return to the Summary Table.

MASK 4

表 9-41. REG20_MASK 4 Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|-----------------|------|-------|----------------------|--|
| 7 | ADC_DONE_MASK | R/W | 0h | Reset by: REG_RST | ADC_DONE Mask Type: R/W POR: 0b 0h = ADC_DONE flag produce INT 1h = ADC_DONE flag does not produce INT |
| 6 | SS_TIMEOUT_MASK | R/W | 0h | Reset by: REG_RST | SS_TIMEOUT Mask Type: R/W POR: 0b 0h = SS_TIMEOUT flag produce INT 1h = SS_TIMEOUT flag does not produce INT |



表 9-41. REG20_MASK 4 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Note | Description |
|-----|----------------------|------|-------|----------------------|---|
| 5 | TSBUS_TSBAT_ALM_MASK | R/W | Oh | Reset by: REG_RST | TSBUS_TSBAT_ALM Mask Type: R/W POR: 0b 0h = TSBUS_TSBAT_ALM flag produce INT 1h = TSBUS_TSBAT_ALM flag does not produce INT |
| 4 | TSBUS_FLT_MASK | R/W | Oh | Reset by: REG_RST | TSBUS_FLT Mask Type: R/W POR: 0b 0h = TSBUS_FLT flag produce ĪNT 1h = TSBUS_FLT flag does not produce ĪNT |
| 3 | TSBAT_FLT_MASK | R/W | Oh | Reset by: REG_RST | TSBAT_FLT Mask Type: R/W POR: 0b 0h = TSBAT_FLT flag produce INT 1h = TSBAT_FLT flag does not produce INT |
| 2 | TDIE_FLT_MASK | R/W | Oh | Reset by: REG_RST | TDIE_FLT Mask Type : R/W POR: 0b 0h = TDIE_FLT flag produce INT 1h = TDIE_FLT flag does not produce INT |
| 1 | TDIE_ALM_MASK | R/W | Oh | Reset by: REG_RST | TDIE_ALM Mask Type: R/W POR: 0b 0h = TDIE_ALM flag produce INT 1h = TDIE_ALM flag does not produce INT |
| 0 | WD_MASK | R/W | Oh | Reset by: REG_RST | Watchdog Mask Type: R/W POR: 0b 0h = WD flag produce INT 1h = WD flag does not produce INT |

9.5.1.34 REG21_MASK 5 Register (Offset = 21h) [reset = 0h]

REG21_MASK 5 is shown in 表 9-42.

Return to the Summary Table.

MASK 5

表 9-42. REG21_MASK 5 Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|------------------|------|-------|----------------------|---|
| 7 | REGN_GOOD_MASK | R/W | 0h | Reset by: REG_RST | REGN_GOOD Mask Type: R/W POR: 0b 0h = REGN_GOOD flag produce INT 1h = REGN_GOOD flag does not produce INT |
| 6 | CONV_ACTIVE_MASK | R/W | 0h | Reset by: REG_RST | CONV_ACTIVE Mask Type: R/W POR: 0b 0h = CONV_ACTIVE flag produce ĪNT 1h = CONV_ACTIVE flag does not produce ĪNT |
| 5 | RESERVED | R/W | Oh | Reset by: REG_RST | RESERVED Type : R/W POR: 0h |



表 9-42. REG21_MASK 5 Register Field Descriptions (continued)

| | pro in it is a region i rola posonipalone (contamada) | | | | | | | | |
|-----|---|------|-------|---------|--|--|--|--|--|
| Bit | Field | Туре | Reset | Note | Description | | | | |
| 4 | VBUS_ERRHI_MASK | R/W | Oh | REG_RST | VBUS_ERRHI Mask Type: R/W POR: 0b 0h = VBUS_ERRHI flag produce INT 1h = VBUS_ERRHI flag does not produce INT | | | | |
| 3-0 | RESERVED | R | 0h | | RESERVED | | | | |

9.5.1.35 REG22_DEVICE_INFO Register (Offset = 22h) [reset = 0h]

REG22_DEVICE_INFO is shown in 表 9-43.

Return to the Summary Table.

DEVICE INFO

表 9-43. REG22_DEVICE_INFO Register Field Descriptions

| _ | | | | | <u> </u> |
|---|-----|----------------|------|-------|----------------------------------|
| | Bit | Field | Туре | Reset | Description |
| | 7-4 | DEVICE_REV_3:0 | R | 0h | Device Revision Type : R POR: 0h |
| | 3-0 | DEVICE_ID_3:0 | R | 0h | Device ID Type : R POR: 0h |

9.5.1.36 REG23_ADC_CONTROL 1 Register (Offset = 23h) [reset = 0h]

REG23_ADC_CONTROL 1 is shown in 表 9-44.

Return to the Summary Table.

ADC_CONTROL 1

表 9-44. REG23_ADC_CONTROL 1 Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|--------------|------|-------|----------------------------------|--|
| 7 | ADC_EN | R/W | 0h | Reset by: WATCHDOG REG_RST | ADC Enable Type: R/W POR: 0b 0h = Disable 1h = Enable |
| 6 | ADC_RATE | R/W | 0h | Reset by: REG_RST | ADC Rate Type: R/W POR: 0b 0h = Continuous conversion 1h = 1 shot |
| 5 | ADC_AVG | R/W | 0h | Reset by: REG_RST | ADC Average Type: R/W POR: 0b 0h = Single value 1h = Running average |
| 4 | ADC_AVG_INIT | R/W | 0h | Reset by: REG_RST | ADC Average Initial Value Type: R/W POR: 0b 0h = Start average using the existing register value 1h = Start average using a new conversion |

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表 9-44. REG23_ADC_CONTROL 1 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Note | Description |
|-----|----------------|------|-------|----------------------|---|
| 3-2 | ADC_SAMPLE_1:0 | R/W | 0h | Reset by: REG_RST | ADC Sample Speed Type: R/W POR: 00b 0h = 15 bit 1h = 14 bit 2h = 13 bit 3h = 11 bit |
| 1 | IBUS_ADC_DIS | R/W | 0h | Reset by: REG_RST | IBUS ADC Control Type: R/W POR: 0b 0h = Enable 1h = Disable |
| 0 | VBUS_ADC_DIS | R/W | 0h | Reset by: REG_RST | VBUS ADC Control Type : R/W POR: 0b 0h = Enable 1h = Disable |

9.5.1.37 REG24_ADC_CONTROL 2 Register (Offset = 24h) [reset = 0h]

REG24_ADC_CONTROL 2 is shown in 表 9-45.

Return to the Summary Table.

ADC_CONTROL 2

表 9-45. REG24_ADC_CONTROL 2 Register Field Descriptions

| Bit | Field | Туре | Reset | Note | Description |
|-----|--------------|------|-------|------|--|
| 7 | VAC1_ADC_DIS | R/W | 0h | | VAC1 ADC Control Type: R/W POR: 0b 0h = Enable 1h = Disable |
| 6 | VAC2_ADC_DIS | R/W | 0h | | VAC2 ADC Control Type: R/W POR: 0b 0h = Enable 1h = Disable |
| 5 | VOUT_ADC_DIS | R/W | 0h | | VOUT ADC Control Type : R/W POR: 0b 0h = Enable 1h = Disable |
| 4 | VBAT_ADC_DIS | R/W | 0h | | VBAT ADC Control Type : R/W POR: 0b 0h = Enable 1h = Disable |
| 3 | IBAT_ADC_DIS | R/W | 0h | | IBAT ADC Control Type: R/W POR: 0b 0h = Enable 1h = Disable |



表 9-45. REG24_ADC_CONTROL 2 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Note | Description |
|-----|---------------|------|-------|----------------------|--|
| 2 | TSBUS_ADC_DIS | R/W | 0h | Reset by: REG_RST | TSBUS ADC Control Type: R/W POR: 0b 0h = Enable 1h = Disable |
| 1 | TSBAT_ADC_DIS | R/W | 0h | Reset by: REG_RST | TSBAT ADC Control Type: R/W POR: 0b 0h = Enable 1h = Disable |
| 0 | TDIE_ADC_DIS | R/W | 0h | Reset by: REG_RST | TDIE ADC Control Type : R/W POR: 0b 0h = Enable 1h = Disable |

9.5.1.38 REG25_IBUS_ADC Register (Offset = 25h) [reset = 0h]

REG25_IBUS_ADC is shown in 表 9-46.

Return to the Summary Table.

IBUS_ADC

表 9-46. REG25_IBUS_ADC Register Field Descriptions

| Bit Field Type Reset Des | escription |
|--|---|
| Typr POF Ran Swit Fixe Bit S Byp Fixe | BUS ADC Reading ype: R OR: 0 mA (0h) ange: 0 mA - 7000 mA witched Cap Mode: ixed Offset: 66 mA it Step Size: 0.9972 mA ypass Mode: ixed Offset: 64 mA it Step Size: 1.0279 mA |

9.5.1.39 REG27_VBUS_ADC Register (Offset = 27h) [reset = 0h]

REG27_VBUS_ADC is shown in 表 9-47.

Return to the Summary Table.

VBUS_ADC

表 9-47. REG27_VBUS_ADC Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-------|---|
| 15-0 | VBUS_ADC_15:0 | R | Oh | VBUS ADC Reading Type: R POR: 0 mV (0h) Range: 0 mV - 16385 mV Fixed Offset: 0 mV Bit Step Size: 1.002 mV |

Product Folder Links: BQ25960

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9.5.1.40 REG29_VAC1_ADC Register (Offset = 29h) [reset = 0h]

REG29_VAC1_ADC is shown in 表 9-48.

Return to the Summary Table.

VAC1_ADC

表 9-48. REG29_VAC1_ADC Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-------|--|
| 15-0 | VAC1_ADC_15:0 | R | 0h | VAC1 ADC Reading Type: R POR: 0 mV (0h) Range: 0 mV - 14000 mV Fixed Offset: 3 mV Bit Step Size: 1.0008 mV |

9.5.1.41 REG2B_VAC2_ADC Register (Offset = 2Bh) [reset = 0h]

REG2B_VAC2_ADC is shown in 表 9-49.

Return to the Summary Table.

VAC2_ADC

表 9-49. REG2B_VAC2_ADC Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-------|--|
| 15-0 | VAC2_ADC_15:0 | R | 0h | VAC2 ADC Reading Type: R POR: 0 mV (0h) Range: 0 mV - 14000 mV Fixed Offset: 5 mV Bit Step Size: 1.0006 mV |

9.5.1.42 REG2D_VOUT_ADC Register (Offset = 2Dh) [reset = 0h]

REG2D VOUT ADC is shown in 表 9-50.

Return to the Summary Table.

VOUT_ADC

表 9-50. REG2D_VOUT_ADC Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-------|---|
| 15-0 | VOUT_ADC_15:0 | R | | VOUT ADC Reading Type: R POR: 0 mV (0h) Range: 0 mV - 6000 mV Fixed Offset: 2 mV Bit Step Size: 1.0037 mV |

Product Folder Links: BQ25960

9.5.1.43 REG2F_VBAT_ADC Register (Offset = 2Fh) [reset = 0h]

REG2F_VBAT_ADC is shown in 表 9-51.

Return to the Summary Table.

VBAT_ADC

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表 9-51. REG2F_VBAT_ADC Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-------|--|
| 15-0 | VBAT_ADC_15:0 | R | 0h | VBAT ADC Reading Type: R POR: 0 mV (0h) Range: 0 mV - 6000 mV Fixed Offset: 1 mV Bit Step Size: 1.017 mV |

9.5.1.44 REG31_IBAT_ADC Register (Offset = 31h) [reset = 0h]

REG31_IBAT_ADC is shown in 表 9-52.

Return to the Summary Table.

IBAT_ADC

表 9-52. REG31_IBAT_ADC Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-------|--|
| 15-0 | IBAT_ADC_15:0 | R | | IBAT ADC Reading Type: R POR: 0 mA (0h) Range: 0 mA - 12000 mA Fixed Offset: -150 mA Bit Step Size: 0.999 mA |

9.5.1.45 REG33_TSBUS_ADC Register (Offset = 33h) [reset = 0h]

REG33_TSBUS_ADC is shown in 表 9-53.

Return to the Summary Table.

TSBUS_ADC

表 9-53. REG33_TSBUS_ADC Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|-------|---|
| 15-0 | TSBUS_ADC_15:0 | R | 0h | TSBUS ADC Reading Type: R POR: 0% (0h) Range: 0% - 50% Fixed Offset: 0.1% Bit Step Size: 0.09860% |

9.5.1.46 REG35_TSBAT_ADC Register (Offset = 35h) [reset = 0h]

REG35_TSBAT_ADC is shown in 表 9-54.

Return to the Summary Table.

TSBAT_ADC

表 9-54. REG35_TSBAT_ADC Register Field Descriptions

| | Bit | Field | Туре | Reset | Description | | | | |
|-----|------|----------------|------|--------------|--------------------------|--|--|--|--|
| | 15-0 | TSBAT_ADC_15:0 | R | 0h | TSBAT ADC Reading | | | | |
| | | | | | Type: R | | | | |
| | | | | POR: 0% (0h) | | | | | |
| | | | | | Range : 0% - 50% | | | | |
| | | | | | Fixed Offset: 0.065% | | | | |
| | | | | | Bit Step Size : 0.09762% | | | | |
| - 1 | | | | | | | | | |



9.5.1.47 REG37_TDIE_ADC Register (Offset = 37h) [reset = 0h]

REG37_TDIE_ADC is shown in 表 9-55.

Return to the Summary Table.

TDIE_ADC

表 9-55. REG37_TDIE_ADC Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-------|--|
| 15-0 | TDIE_ADC_15:0 | R | | TDIE ADC Reading Type: R POR: 0°C (0h) Range: -40°C - 150°C Fixed Offset: -3.5°C Bit Step Size: 0.5079°C |

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10 Application and Implementation

注

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10.1 Application Information

A typical application consists of the device configured as an I²C controlled parallel charger along with a standard switching charger, however, it can also be used with a linear charger or PMIC with integrated charger as well. BQ25960 can start fast charging after the main charger completes pre-charging. BQ25960 will then hand back charging to the main charger when final current tapering is desired. This point is usually where the efficiency of the main charger is acceptable for the application. The device can be used to charge Li-lon and Li-polymer batteries used in a wide range of smartphones and other portable devices. To take advantage of the high charge current capabilities of the BQ25960, it may be necessary to charge in excess of 1C. In this case, be sure to follow the battery manufacturers recommendations closely.

Product Folder Links: BQ25960

10.2 Typical Application

A typical schematic is shown below with all the optional and required components shown.



10.2.1 Standalone Application Information (for use with main charger)

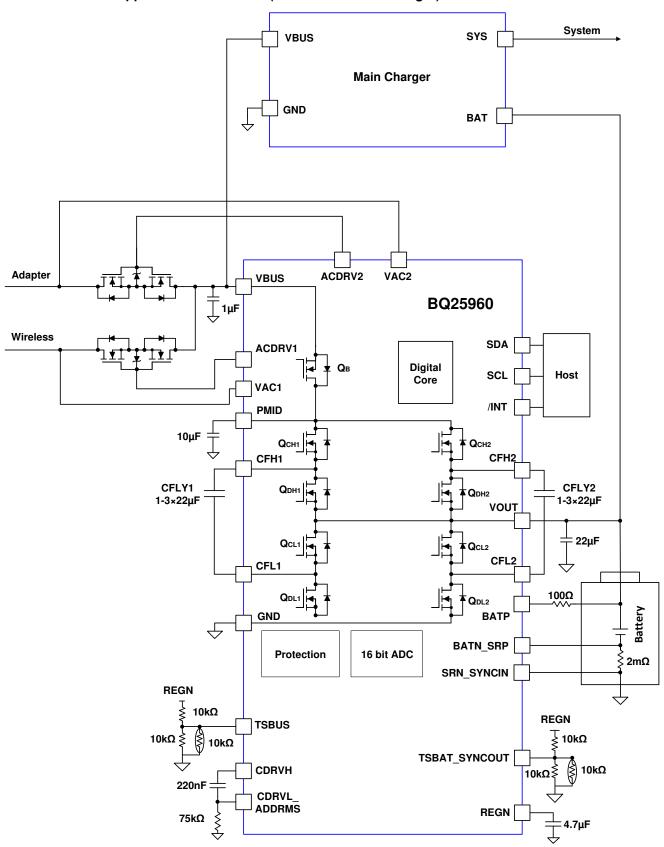


図 10-1. BQ25960 Typical Application Diagram with Dual Input



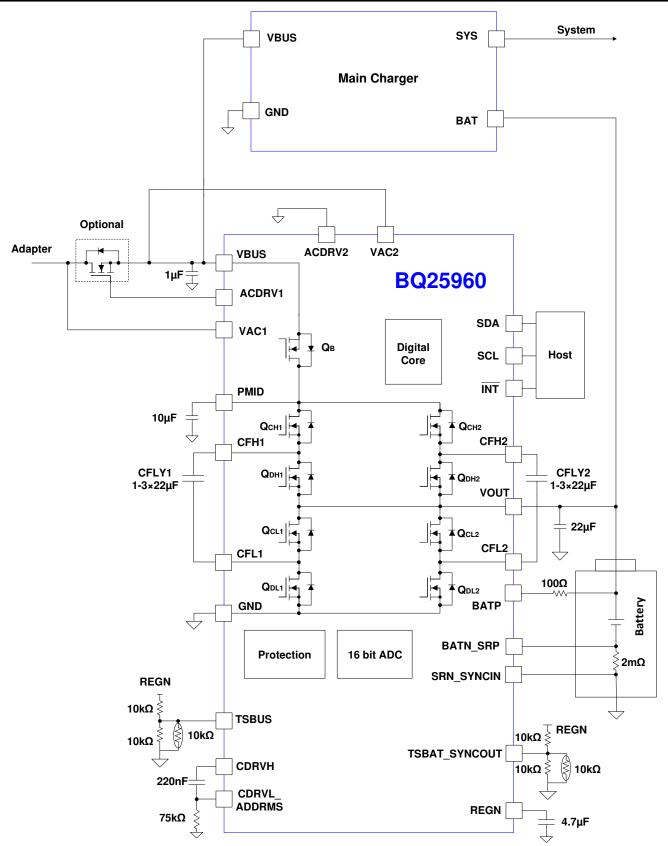


図 10-2. BQ25960 Typical Application Diagram with Single Input



10.2.1.1 Design Requirements

The design requires a smart wall adapter to provide the proper input voltage and input current to the BQ25960, following the USB_PD Programmable Power Supply (PPS) voltage steps and current steps. The design shown is capable of charging up to 8 A, although this may not be practical for some applications due to the total power loss at this operating point. Careful consideration of the thermal constraints, space constraints, and operating conditions should be done to ensure acceptable performance.

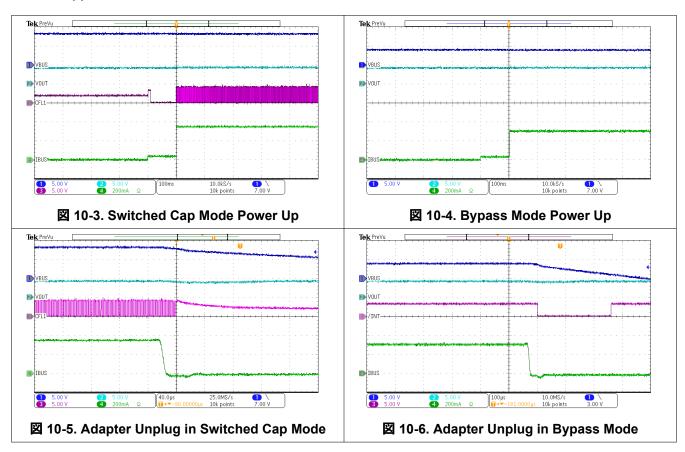
10.2.1.2 Detailed Design Procedure

The first step is to determine the number of CFLY caps to put on each phase of the design. It is important to consider the current rating of the caps, their ESR, and the capacitance rating. Be sure to consider the bias voltage derating for the caps, as the CFLY caps are biased to half of the input voltage, and this will affect their effective capacitance. An optimal system will have 3 22-µF caps per phase, for a total of 6 caps per device. It is possible to use fewer caps if the board space is limited. Using fewer caps will result in higher voltage and current ripple on the output, as well as lower efficiency.

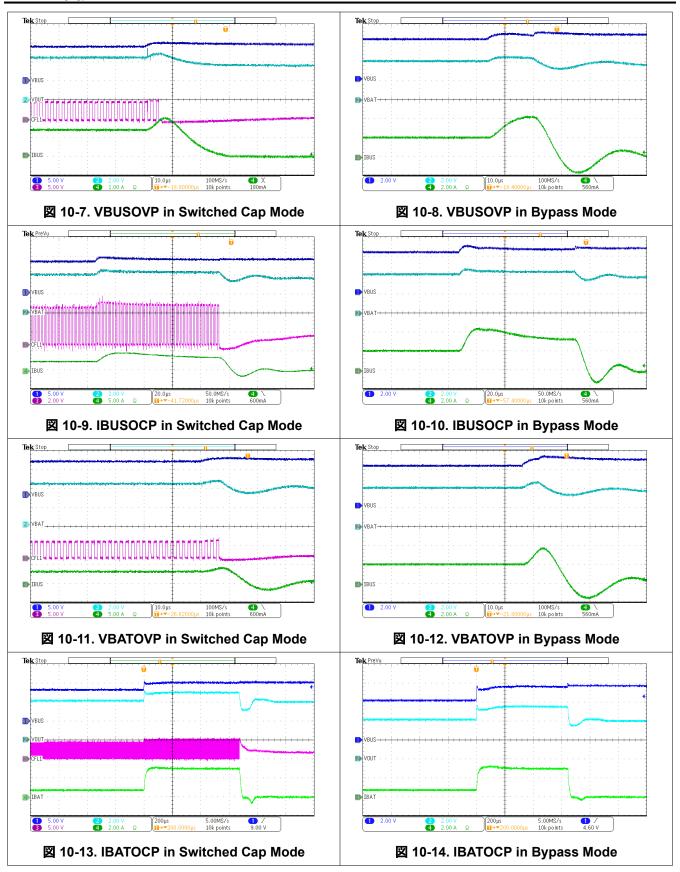
The default switching frequency, f_{SW} , for the power stage is 500 kHz. The switching frequency can be adjusted in register 0x10h using the FSW_SET bits. It is recommended to select 500 kHz if IBATADC is not used and 375 kHz if IBATADC is used.

It is recommended to use 1-μF cap on VBUS, 10-μF cap on PMID and 22-μF cap on VOUT.

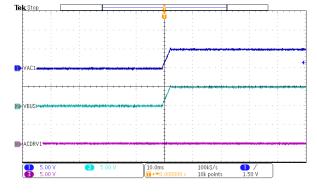
10.2.1.3 Application Curves





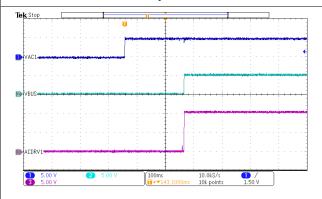






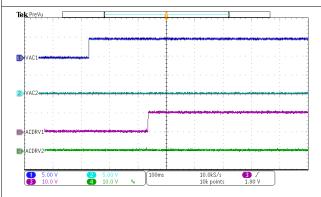
VAC1 and VAC2 short to VBUS, ACDRV1 and ACDRV2 short to ground

図 10-15. Power Up without AC-RFFET



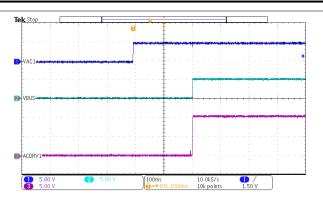
VAC1 connected to input source 1, VBUS connected to input source 2, VAC2 short to VBUS, ACDRV1 active, ACDRV2 short to ground

図 10-17. Power Up from VAC1 with ACFET1-RBFET1



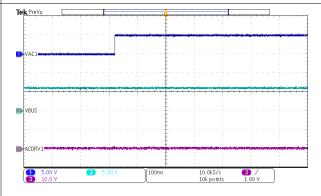
VAC1 connected to input source 1, VAC2 connected to input source 2, ACDRV1 and ACDRV2 active

図 10-19. Power Up from VAC1 with ACFET1-RBFET1 and ACFET2-RBFET2



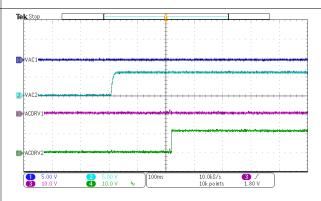
VAC1 connected to input source, VAC2 short to VBUS, ACDRV1 active, ACDRV2 short to ground

図 10-16. Power Up from VAC1 with Single ACFET1



VAC1 connected to input source 1, VBUS connected to input source 2, VAC2 short to VBUS, ACDRV1 active, ACDRV2 short to ground

図 10-18. Plugin VAC1 When Device is Power Up From VBUS with ACFET1-RBFET1



VAC1 connected to input source 1, VAC2 connected to input source 2, ACDRV1 and ACumDRV2 active

図 10-20. Power Up from VAC2 with ACFET1-RBFET1 and ACFET2-RBFET2



11 Power Supply Recommendations

The BQ25960 can be powered by a standard power supply capable of meeting the input voltage and current requirements for evaluation. In the actual application, it must be used with a wall adapter that supports USB Power Delivery (PD) Programmable Power Supply (PPS) specifications.

Product Folder Links: BQ25960

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12 Layout

12.1 Layout Guidelines

Layout is very important to maximize the electrical and thermal performance of the total system. General guidelines are provided, but the form factor, board stack-up, and proximity of other components also need to be considered to maximize the performance.

- 1. VBUS and VOUT traces should be as short and wide as possible to accommodate for high current.
- 2. Copper trace of VBUS and VOUT should run at least 150 mil (3.81 mm) straight (perpendicular to WCSP ball array) before making turns.
- 3. CFLY caps should be placed as close as possible to the device and CFLY trace should be as wide as possible until close to the IC.
- 4. CLFY pours should be as symmetrical between CFH pads and CFL pads as possible.
- 5. Place low ESR bypass capacitors to ground for VBUS, PMID, and VOUT. The capacitor should be placed as close to the device pins as possible.
- 6. The CFLY pads should be as small as possible, and the CFLY caps placed as close as possible to the device, as these are switching pins and this will help reduce EMI.
- 7. Do not route so the power planes are interrupted by signal traces.

Refer to the EVM design and more information in the BQ25960EVM (BMS041) Evaluation Module User's Guide for the recommended component placement with trace and via locations.

12.2 Layout Example

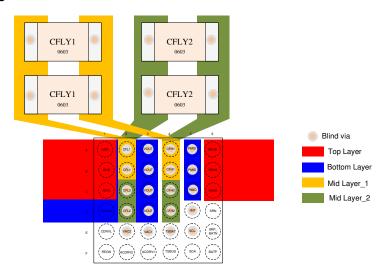


図 12-1. BQ25960 Layout Example

English Data Sheet: SLUSE08



13 Device and Documentation Support

13.1 Device Support

13.1.1 サード・パーティ製品に関する免責事項

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13.2 Documentation Support

13.2.1 Related Documentation

For related documentation see the following:

BQ25960EVM (BMS041) Evaluation Module User's Guide

13.3 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、ti.com のデバイス製品フォルダを開いてください。「更新の通知を受け取る」をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取れます。変更の詳細については、修正されたドキュメントに含まれている改訂履歴をご覧ください。

13.4 サポート・リソース

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Product Folder Links: BQ25960

13.5 Trademarks

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13.6 静電気放電に関する注意事項



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ESD による破損は、わずかな性能低下からデバイスの完全な故障まで多岐にわたります。精密な IC の場合、パラメータがわずかに変化するだけで公表されている仕様から外れる可能性があるため、破損が発生しやすくなっています。

13.7 用語集

TI 用語集 この用語集には、用語や略語の一覧および定義が記載されています。

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14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

www.ti.com 23-May-2025

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material | MSL rating/ Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|---------------|---------------|------------------|-----------------------|-----------------|-------------------------------|----------------------------|--------------|------------------|
| BQ25960YBGR | Active | Production | DSBGA (YBG) 36 | 3000 LARGE T&R | Yes | SNAGCU | Level-1-260C-UNLIM | -40 to 85 | BQ25960 |
| BQ25960YBGR.A | Active | Production | DSBGA (YBG) 36 | 3000 LARGE T&R | Yes | SNAGCU | Level-1-260C-UNLIM | -40 to 85 | BQ25960 |
| BQ25960YBGR.B | Active | Production | DSBGA (YBG) 36 | 3000 LARGE T&R | Yes | SNAGCU | Level-1-260C-UNLIM | -40 to 85 | BQ25960 |

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

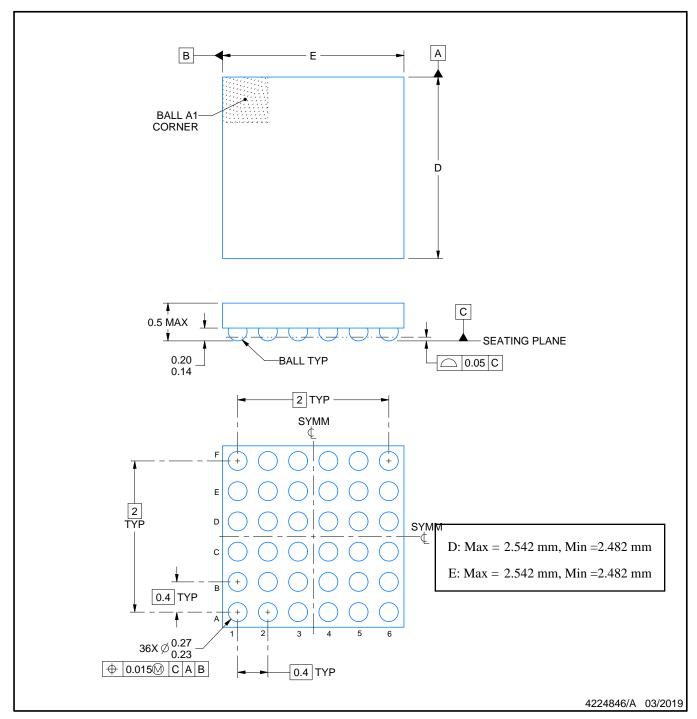
⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



DIE SIZE BALL GRID ARRAY



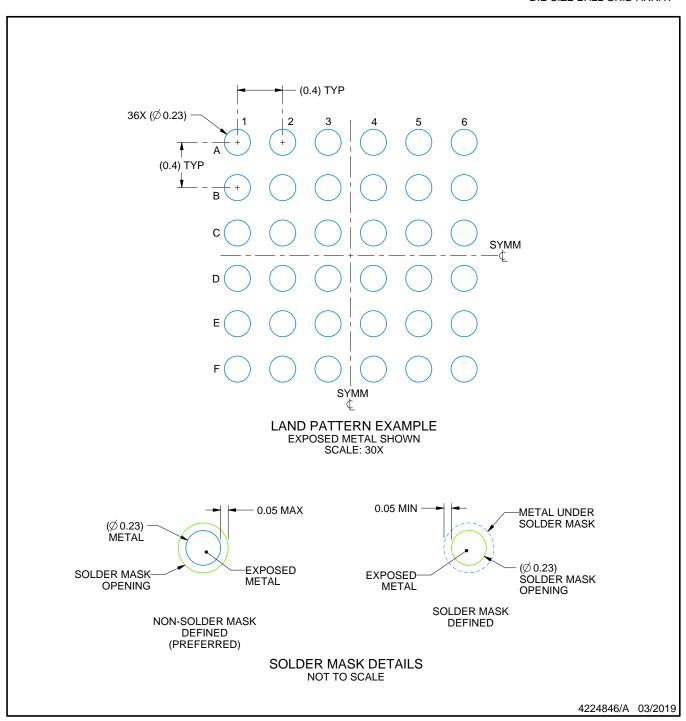
NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.



DIE SIZE BALL GRID ARRAY

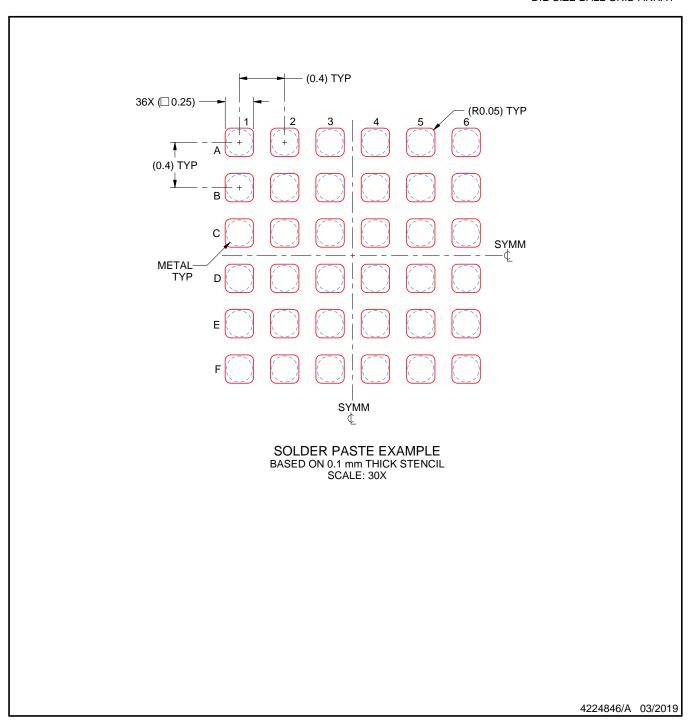


NOTES: (continued)

3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. See Texas Instruments Literature No. SNVA009 (www.ti.com/lit/snva009).



DIE SIZE BALL GRID ARRAY



NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



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